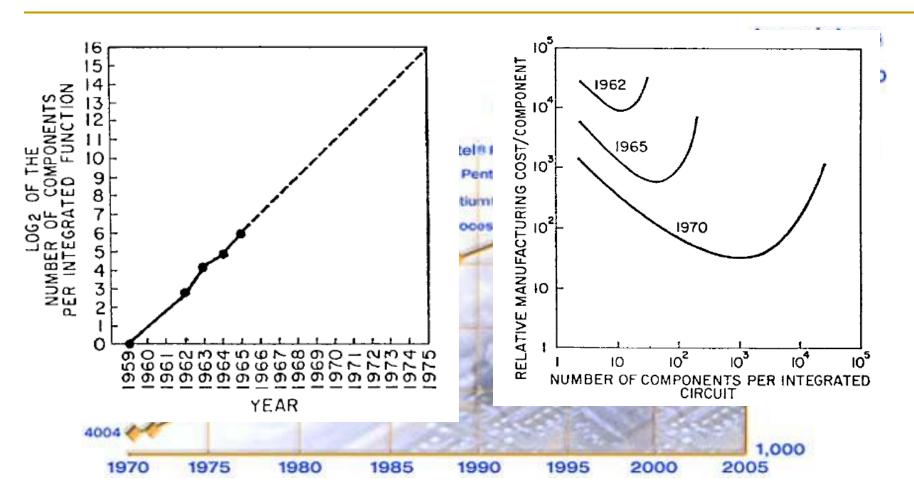
# 18-740: Computer Architecture Recitation 2:Rethinking Memory System Design

Prof. Onur Mutlu Carnegie Mellon University Fall 2015 September 8, 2015

Igenda

- Why Do Research in Computer Architecture?
- Project Proposal, Timeline, Topics
- Review Assignments for Next Week
- Rethinking Memory System Design

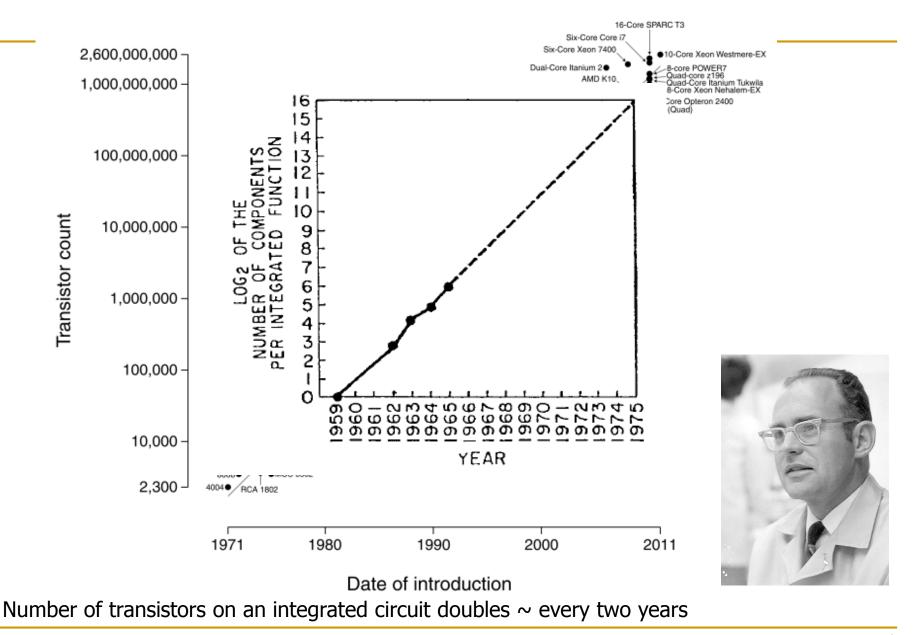
#### An Enabler: Moore's Law



Moore, "Cramming more components onto integrated circuits," Electronics Magazine, 1965. Component counts double every other year

Image source: Intel

#### Microprocessor Transistor Counts 1971-2011 & Moore's Law



### Recommended Reading

- Moore, "Cramming more components onto integrated circuits," Electronics Magazine, 1965.
- Only 3 pages
- A quote:

"With unit cost falling as the number of components per circuit rises, by 1975 economics may dictate squeezing as many as 65 000 components on a single silicon chip."

#### Another quote:

"Will it be possible to remove the heat generated by tens of thousands of components in a single silicon chip?"

#### When Moore's Law Ends ...

- All good things come to an end
- How you architect systems will be even more important
   When technology scaling ends or becomes more difficult
- Every new beginning is another beginning's end
  - Even if there is a replacement scalable technology, it will require new architectures to take advantage of it

### Why Do Computer Architecture Research?

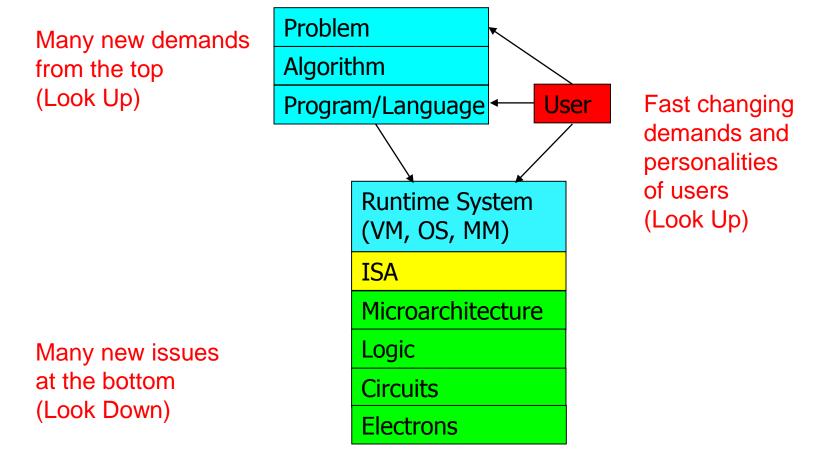
- Enable better systems: make computers faster, cheaper, smaller, more reliable, ...
  - By exploiting advances and changes in underlying technology/circuits
- Enable new applications
  - □ Life-like 3D visualization 20 years ago?
  - Virtual reality?
  - Personalized genomics? Personalized medicine?
- Enable better solutions to problems
  - Software innovation is built into trends and changes in computer architecture
    - > 50% performance improvement per year has enabled this innovation
- Overcome the challenges

# Computer Architecture Today (I)

- Today is a very exciting time to study computer architecture
- Industry is in a large paradigm shift (to multi-core and beyond) – many different potential system designs possible
- Many difficult problems motivating and caused by the shift
  - Power/energy constraints  $\rightarrow$  multi-core?
  - □ Complexity of design  $\rightarrow$  multi-core?
  - Difficulties in technology scaling  $\rightarrow$  new technologies?
  - Memory wall/gap
  - Reliability wall/issues
  - Programmability wall/problem
  - Huge hunger for data and new data-intensive applications
- No clear, definitive answers to these problems

### Computer Architecture Today (II)

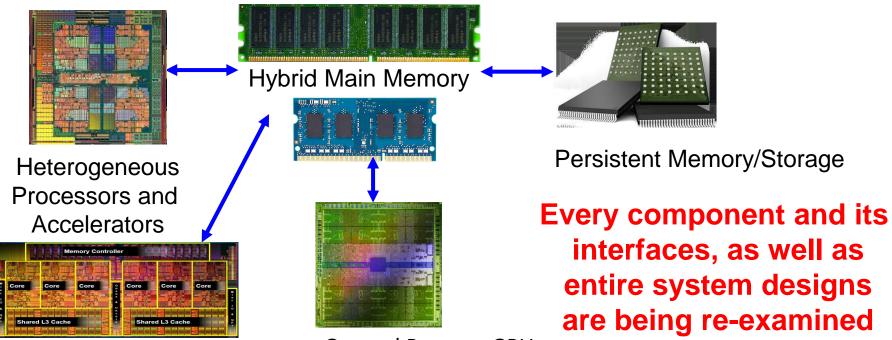
 These problems affect all parts of the computing stack – if we do not change the way we design systems



No clear, definitive answers to these problems

# Computer Architecture Today (III)

- Computing landscape is very different from 10-20 years ago
- Both UP (software and humanity trends) and DOWN (technologies and their issues), FORWARD and BACKWARD, and the resulting requirements and constraints



General Purpose GPUs

### Computer Architecture Today (IV)

- You can revolutionize the way computers are built, if you understand both the hardware and the software (and change each accordingly)
- You can invent new paradigms for computation, communication, and storage
- Recommended book: Thomas Kuhn, "The Structure of Scientific Revolutions" (1962)
  - Pre-paradigm science: no clear consensus in the field
  - Normal science: dominant theory used to explain/improve things (business as usual); exceptions considered anomalies
  - Revolutionary science: underlying assumptions re-examined

# Computer Architecture Today (IV)

You can revolutionize the way computers are built, if you understand boti the intervention of tware (and change each ac

 You can ir communic

- Recomme Scientific | R E V
  - Pre-para тно
  - Normal : things (t)
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- Why Do Research in Computer Architecture?
- Project Proposal, Timeline, Topics
- Review Assignments for Next Week
- Rethinking Memory System Design

# Project Proposal and Topics

### Research Project

- Your chance to explore in depth a computer architecture topic that interests you
- Perhaps even publish your innovation in a top computer architecture conference.
- Start thinking about your project topic from now!
- Interact with me and Nandita
- Read the project topics handout well
- Groups of 2-3 students (will finalize this later)
- Proposal due: within ~3-4 weeks of first recitation session
  Exact date will be approximed
  - Exact date will be announced

#### Project Timeline

- Pre-Proposal: September 15
- Proposal: September 25
- Milestone 1 + Literature Review: October 13
- Milestone 2: November 10
- Report, Talk, Poster: TBD
- http://www.ece.cmu.edu/~ece740/f15/doku.php?id=projec ts

### Research Project

- Goal: Develop (new) insight
  - Solve a problem in a new way or evaluate/analyze systems/ideas
  - Type 1:
    - Develop new ideas to solve an important problem
    - Rigorously evaluate the benefits and limitations of the ideas
  - Type 2:
    - Derive insight from rigorous analysis and understanding of existing systems or previously proposed ideas
    - Propose potential new solutions based on the new insight
- The problem and ideas need to be concrete
- Problem and goals need to be very clear

# Research Proposal Outline: Type 1

- The Problem: What is the problem you are trying to solve
  - Define very clearly. Explain why it is important.
- Novelty: Why has previous research not solved this problem? What are its shortcomings?
  - Describe/cite all relevant works you know of and describe why these works are inadequate to solve the problem. This will be your literature survey.
- Idea: What is your initial idea/insight? What new solution are you proposing to the problem? Why does it make sense? How does/could it solve the problem better?
- Hypothesis: What is the main hypothesis you will test?
- Methodology: How will you test the hypothesis/ideas? Describe what simulator or model you will use and what initial experiments you will do.
- Plan: Describe the steps you will take. What will you accomplish by Milestone 1, 2, 3, and Final Report? Give 75%, 100%, 125% and moonshot goals.

All research projects can be (and should be) described in this fashion.

# Research Proposal Outline: Type 2

- The Problem: What is the problem/phenomenon you are trying to evaluate?
   Define very clearly. Explain why it is important.
- Novelty: How has previous research evaluated this? What are its shortcomings?
  - Describe/cite all relevant works you know of and describe why these works are inadequate to solve the problem. This will be your literature survey.
- Evaluation method: How will you evaluate the phenomenon/idea? What experimental infrastructure will you design? How would that experimental infrastructure enable you to reliably evaluate the phenomenon/idea?
- Hypotheses: What hypotheses will you test?
- Methodology: What are your plans for evaluation? What experiments will you run? How will you do the data analysis?
- Plan: Describe the steps you will take. What will you accomplish by Milestone 1, 2, 3, and Final Report? Give 75%, 100%, 125% and moonshot goals.

All research projects can be (and should be) described in this fashion.

#### Heilmeier's Catechism (version 1)

- What are you trying to do? Articulate your objectives using absolutely no jargon.
- How is it done today, and what are the limits of current practice?
- What's new in your approach and why do you think it will be successful?
- Who cares?
- If you're successful, what difference will it make?
- What are the risks and the payoffs?
- How much will it cost?
- How long will it take?
- What are the midterm and final "exams" to check for success?

#### Heilmeier's Catechism (version 2)

- What is the problem?
- Why is it hard?
- How is it solved today?
- What is the new technical idea?
- Why can we succeed now?
- What is the impact if successful?
- http://en.wikipedia.org/wiki/George\_H.\_Heilmeier

Supplementary Readings on Research, Writing, Reviews

 Hamming, "You and Your Research," Bell Communications Research Colloquium Seminar, 7 March 1986.

<u>http://www.cs.virginia.edu/~robins/YouAndYourResearch.html</u>

- Levin and Redell, "How (and how not) to write a good systems paper," OSR 1983.
- Smith, "The Task of the Referee," IEEE Computer 1990.
   Read this to get an idea of the publication process
- SP Jones, "How to Write a Great Research Paper"
- Fong, "How to Write a CS Research Paper: A Bibliography"

### Where to Get Project Topics/Ideas From

- Project topics handout
- Assigned readings
- Recent conference proceedings
  - ISCA: <u>http://www.informatik.uni-trier.de/~ley/db/conf/isca/</u>
  - MICRO: <u>http://www.informatik.uni-</u> trier.de/~ley/db/conf/micro/
  - HPCA: <u>http://www.informatik.uni-trier.de/~ley/db/conf/hpca/</u>
  - ASPLOS: <u>http://www.informatik.uni-</u> trier.de/~ley/db/conf/asplos/



- Why Do Research in Computer Architecture?
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- Rethinking Memory System Design

# Review Assignments for Next Week

### **Required Reviews**

- Due Tuesday Sep 15 @ 3pm
- Enter your reviews on the review website
- Start discussing ideas and thoughts on Piazza

# Review Paper 1 (Required)

 Junwhan Ahn, Sungpack Hong, Sungjoo Yoo, Onur Mutlu, and Kiyoung Choi,
 "A Scalable Processing-in-Memory Accelerator for Parallel Graph Processing"
 Proceedings of the <u>42nd International Symposium on</u> <u>Computer Architecture</u> (ISCA), Portland, OR, June 2015.
 [Slides (pdf)] [Lightning Session Slides (pdf)]

- Related reading (no review required):
  - Junwhan Ahn, Sungjoo Yoo, <u>Onur Mutlu</u>, and Kiyoung Choi, "PIM-Enabled Instructions: A Low-Overhead, Locality-Aware Processing-in-Memory Architecture" Proceedings of the <u>42nd International Symposium on Computer Architecture</u> (ISCA), Portland, OR, June 2015. [Slides (pdf)] [Lightning Session Slides (pdf)]

# Review Paper 2 (Required)

 Stephen W. Keckler, William J. Dally, Brucek Khailany, Michael Garland, David Glasco,
 GPUs and the Future of Parallel Computing, IEEE Micro 2011.

- Background reading (no review required)
  - Nickolls and Dally, The GPU Computing Era, IEEE Micro 2010.
- Related reading (no review required)
  - Schulte et al., Achieving Exascale Capabilities through Heterogeneous Computing, IEEE Micro 2015.
    - http://dx.doi.org/10.1109/MM.2015.71

# Review Paper 3 (Required)

- Jeffrey D. Ullman, Experiments as Research Validation: Have We Gone Too Far?, CACM 2015.
  - http://cacm.acm.org/magazines/2015/9/191183-experimentsas-research-validation/fulltext

- Related reading (no review required):
  - Michael Mitzenmacher, Theory Without Experiments: Have We Gone Too Far?, CACM 2015.
    - http://cacm.acm.org/magazines/2015/9/191184-theory-withoutexperiments/fulltext

# Review Paper 4 (Required)

 Nandita Vijaykumar, Gennady Pekhimenko, Adwait Jog, Abhishek Bhowmick, Rachata Ausavarungnirun, Chita Das, Mahmut Kandemir, Todd C. Mowry, and Onur Mutlu,
 "A Case for Core-Assisted Bottleneck Acceleration in GPUs: Enabling Flexible Data Compression with Assist Warps"

Proceedings of the <u>42nd International Symposium on</u> <u>Computer Architecture</u> (**ISCA**), Portland, OR, June 2015. [Slides (pptx) (pdf)] [Lightning Session Slides (pptx) (pdf)]

# Review Paper 5 (Optional)

 Yu Cai, Yixin Luo, Saugata Ghose, Erich F. Haratsch, Ken Mai, and Onur Mutlu,
 "Read Disturb Errors in MLC NAND Flash Memory: Characterization and Mitigation"
 Proceedings of the <u>45th Annual IEEE/IFIP International</u>
 <u>Conference on Dependable Systems and Networks</u> (DSN), Rio de Janeiro, Brazil, June 2015.
 [Slides (pptx) (pdf)]



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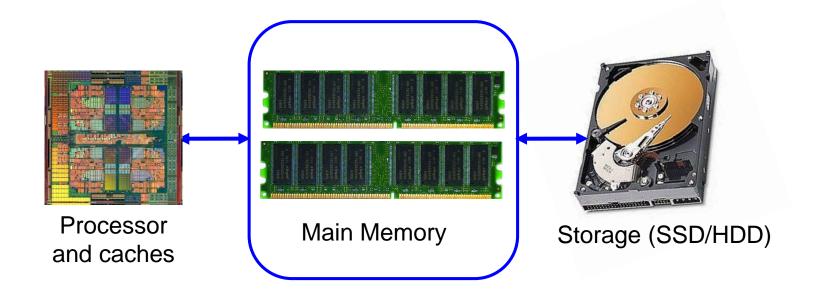
# Rethinking Memory System Design (for Data-Intensive Computing)

Prof. Onur Mutlu 18-740 Recitation 2 September 8, 2015



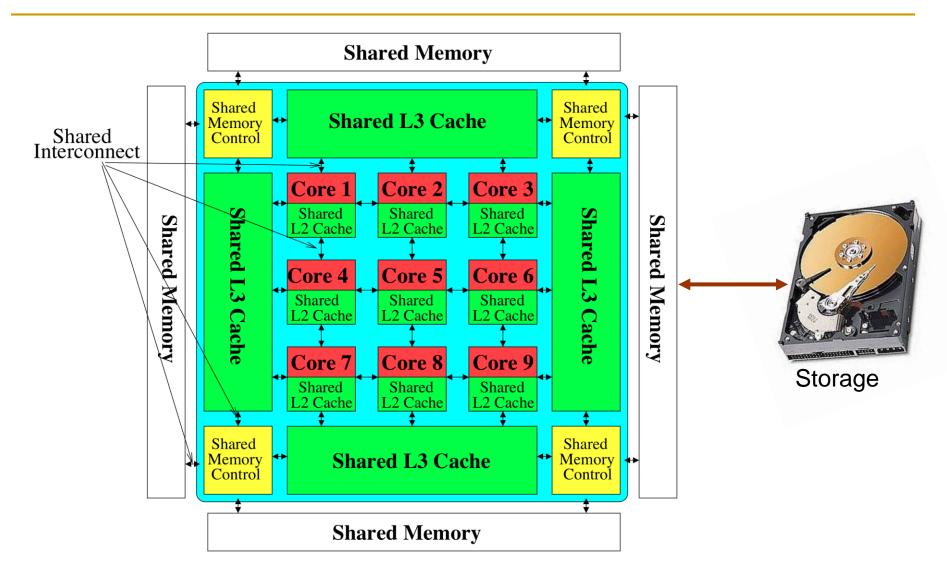
#### SAFARI

# The Main Memory System



- Main memory is a critical component of all computing systems: server, mobile, embedded, desktop, sensor
- Main memory system must scale (in size, technology, efficiency, cost, and management algorithms) to maintain performance growth and technology scaling benefits

#### Memory System: A *Shared Resource* View



#### SAFARI

#### State of the Main Memory System

- Recent technology, architecture, and application trends
  - lead to new requirements
  - exacerbate old requirements
- DRAM and memory controllers, as we know them today, are (will be) unlikely to satisfy all requirements
- Some emerging non-volatile memory technologies (e.g., PCM) enable new opportunities: memory+storage merging
- We need to rethink the main memory system
   to fix DRAM issues and enable emerging technologies
   to satisfy all requirements

#### SAFARI



- Major Trends Affecting Main Memory
- The Memory Scaling Problem and Solution Directions
  - New Memory Architectures
  - Enabling Emerging Technologies
- How Can We Do Better?
- Summary

### Major Trends Affecting Main Memory (I)

Need for main memory capacity, bandwidth, QoS increasing

Main memory energy/power is a key system design concern

DRAM technology scaling is ending

### Major Trends Affecting Main Memory (II)

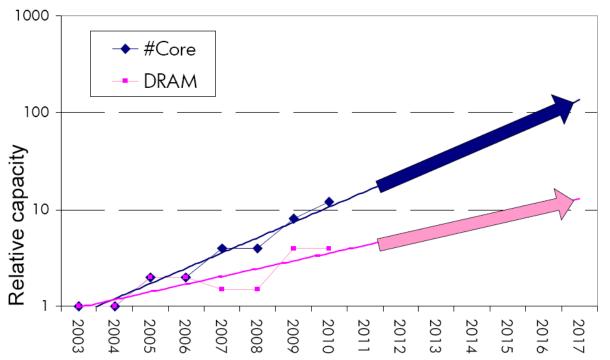
- Need for main memory capacity, bandwidth, QoS increasing
  - Multi-core: increasing number of cores/agents
  - Data-intensive applications: increasing demand/hunger for data
  - Consolidation: cloud computing, GPUs, mobile, heterogeneity

• Main memory energy/power is a key system design concern

DRAM technology scaling is ending

# Example: The Memory Capacity Gap

Core count doubling ~ every 2 years DRAM DIMM capacity doubling ~ every 3 years



*Memory capacity per core* expected to drop by 30% every two years
Trends worse for *memory bandwidth per core*!

## Major Trends Affecting Main Memory (III)

Need for main memory capacity, bandwidth, QoS increasing

- Main memory energy/power is a key system design concern
  - ~40-50% energy spent in off-chip memory hierarchy [Lefurgy, IEEE Computer 2003]
  - DRAM consumes power even when not used (periodic refresh)
- DRAM technology scaling is ending

# Major Trends Affecting Main Memory (IV)

Need for main memory capacity, bandwidth, QoS increasing

### Main memory energy/power is a key system design concern

### DRAM technology scaling is ending

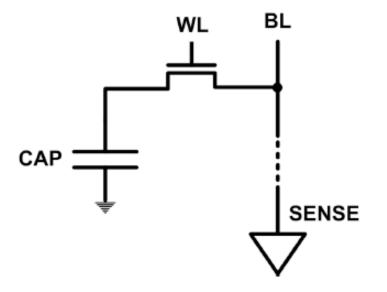
- ITRS projects DRAM will not scale easily below X nm
- Scaling has provided many benefits:
  - higher capacity (density), lower cost, lower energy



- Major Trends Affecting Main Memory
- The Memory Scaling Problem and Solution Directions
  - New Memory Architectures
  - Enabling Emerging Technologies
- How Can We Do Better?
- Summary

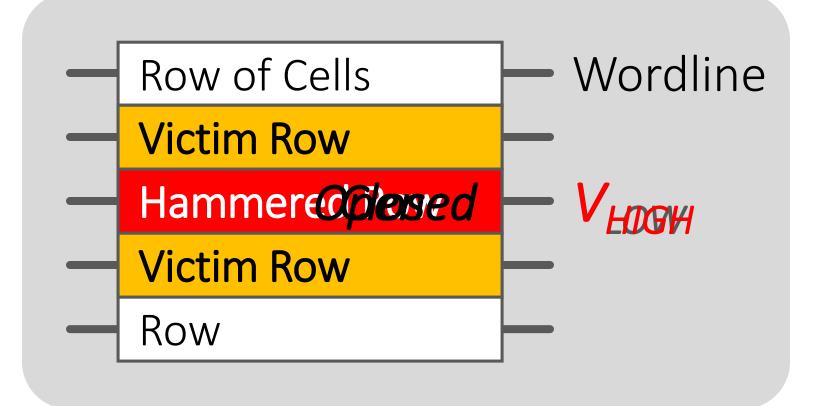
# The DRAM Scaling Problem

- DRAM stores charge in a capacitor (charge-based memory)
  - Capacitor must be large enough for reliable sensing
  - Access transistor should be large enough for low leakage and high retention time
  - □ Scaling beyond 40-35nm (2013) is challenging [ITRS, 2009]



DRAM capacity, cost, and energy/power hard to scale

## An Example of the DRAM Scaling Problem



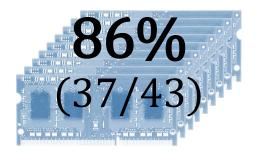
Repeatedly opening and closing a row enough times within a refresh interval induces **disturbance errors** in adjacent rows in **most real DRAM chips you can buy today** 

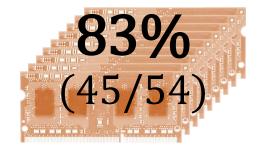
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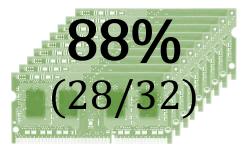
<u>Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM</u> <u>Disturbance Errors</u>, (Kim et al., ISCA 2014)

# Most DRAM Modules Are at Risk



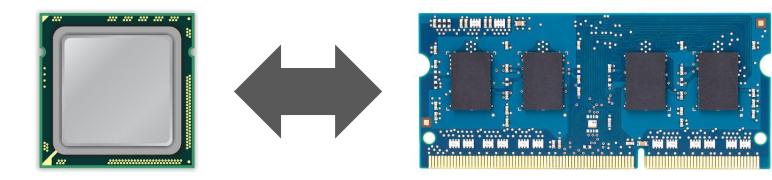




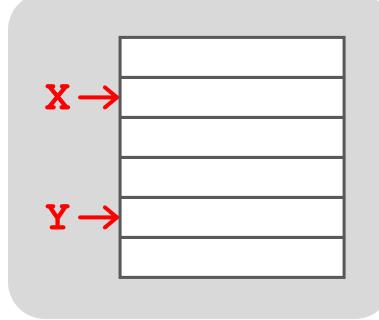


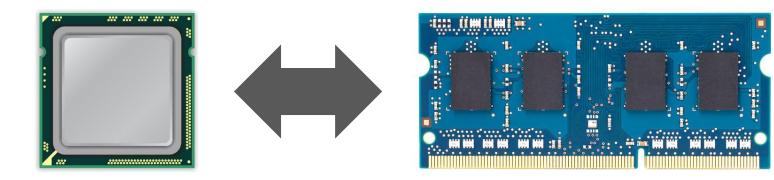
Up to	Up to	Up to
<b>1.0×10</b> <sup>7</sup>	2.7×10 <sup>6</sup>	<b>3.3×10</b> <sup>5</sup>
errors	errors	errors

<u>Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM</u> <u>Disturbance Errors</u>, (Kim et al., ISCA 2014)

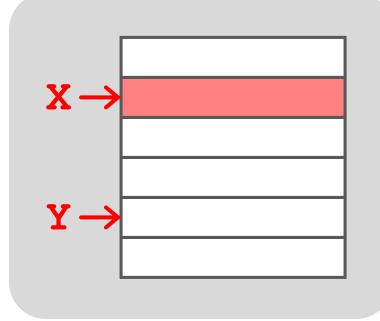


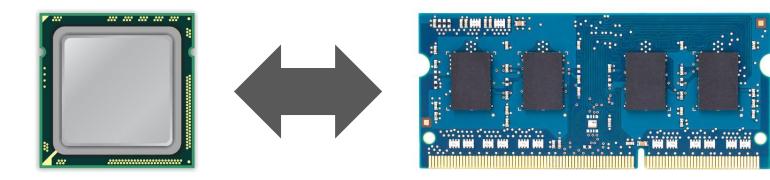
loop: mov (X), %eax mov (Y), %ebx clflush (X) clflush (Y) mfence jmp loop



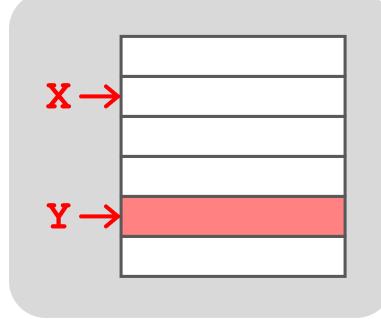


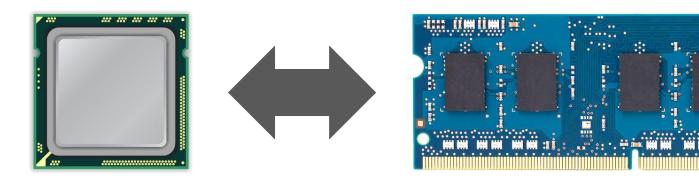
loop: mov (X), %eax mov (Y), %ebx clflush (X) clflush (X) mfence jmp loop



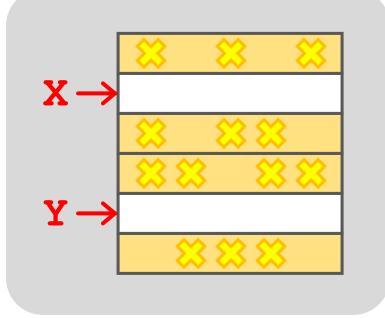


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loop: mov (X), %eax mov (Y), %ebx clflush (X) clflush (Y) mfence jmp loop



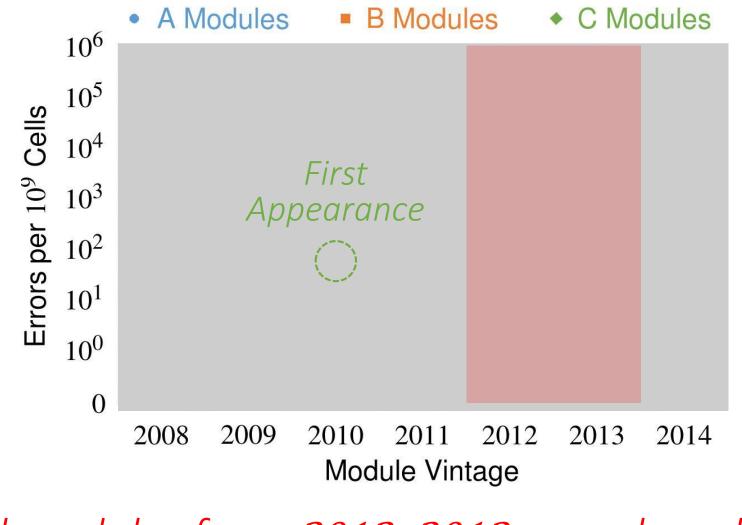
# Observed Errors in Real Systems

CPU Architecture	Errors	Access-Rate
Intel Haswell (2013)	22.9K	12.3M/sec
Intel Ivy Bridge (2012)	20.7K	11.7M/sec
Intel Sandy Bridge (2011)	16.1K	11.6M/sec
AMD Piledriver (2012)	59	6.1M/sec

- A real reliability & security issue
- In a more controlled environment, we can induce as many as ten million disturbance errors

Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.

# Errors vs. Vintage



All modules from 2012–2013 are vulnerable

# Experimental DRAM Testing Infrastructure

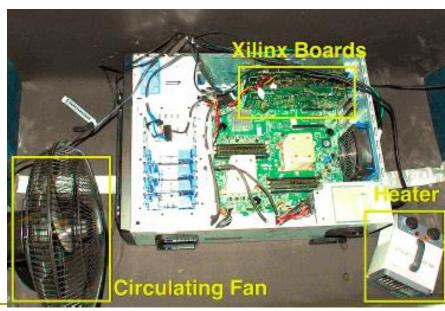


Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors (Kim et al., ISCA 2014)

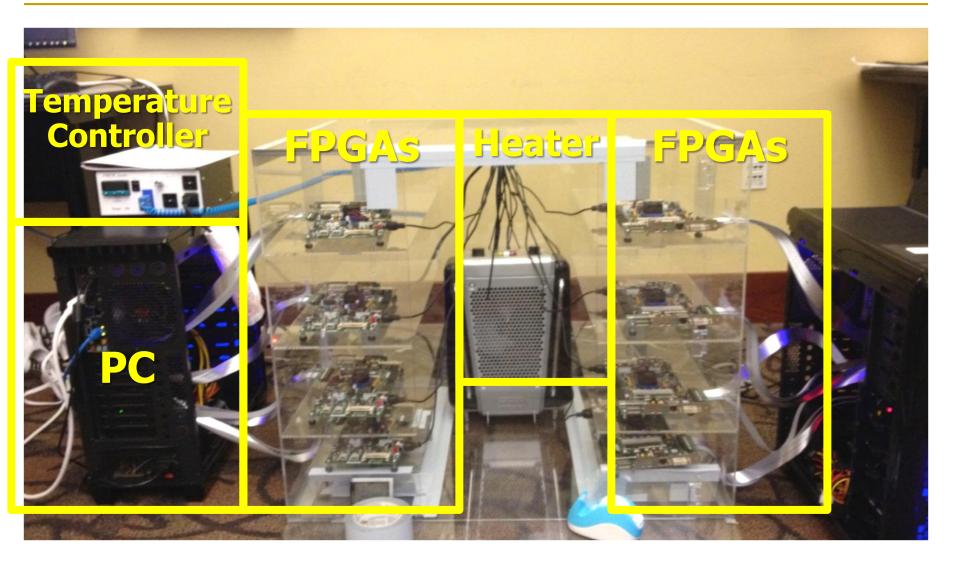
Adaptive-Latency DRAM: Optimizing DRAM Timing for the Common-Case (Lee et al., HPCA 2015)

AVATAR: A Variable-Retention-Time (VRT) Aware Refresh for DRAM Systems (Qureshi et al., DSN 2015) An Experimental Study of Data Retention Behavior in Modern DRAM Devices: Implications for Retention Time Profiling Mechanisms (Liu et al., ISCA 2013)

The Efficacy of Error Mitigation Techniques for DRAM Retention Failures: A Comparative Experimental Study (Khan et al., SIGMETRICS 2014)



### Experimental Infrastructure (DRAM)



### SAFARI

Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.

# RowHammer Characterization Results

- 1. Most Modules Are at Risk
- 2. Errors vs. Vintage
- 3. Error = Charge Loss
- 4. Adjacency: Aggressor & Victim
- 5. Sensitivity Studies
- 6. Other Results in Paper
- 7. Solution Space

Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors, (Kim et al., ISCA 2014)

### One Can Take Over an Otherwise-Secure System

### Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors

Abstract. Memory isolation is a key property of a reliable and secure computing system — an access to one memory address should not have unintended side effects on data stored in other addresses. However, as DRAM process technology

# Project Zero

Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors (Kim et al., ISCA 2014)

News and updates from the Project Zero team at Google

Exploiting the DRAM rowhammer bug to gain kernel privileges (Seaborn, 2015)

Monday, March 9, 2015

Exploiting the DRAM rowhammer bug to gain kernel privileges

### RowHammer Security Attack Example

- "Rowhammer" is a problem with some recent DRAM devices in which repeatedly accessing a row of memory can cause bit flips in adjacent rows (Kim et al., ISCA 2014).
  - Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors (Kim et al., ISCA 2014)
- We tested a selection of laptops and found that a subset of them exhibited the problem.
- We built two working privilege escalation exploits that use this effect.
  - Exploiting the DRAM rowhammer bug to gain kernel privileges (Seaborn, 2015)
- One exploit uses rowhammer-induced bit flips to gain kernel privileges on x86-64 Linux when run as an unprivileged userland process.
- When run on a machine vulnerable to the rowhammer problem, the process was able to induce bit flips in page table entries (PTEs).
- It was able to use this to gain write access to its own page table, and hence gain read-write access to all of physical memory.

### Security Implications



# Recap: The DRAM Scaling Problem

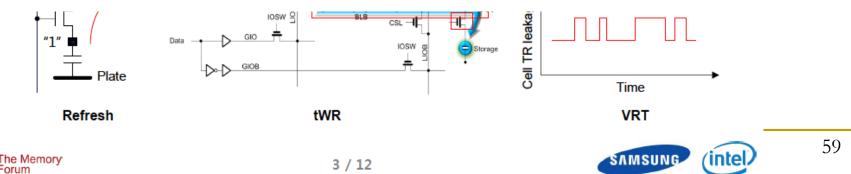
### **DRAM Process Scaling Challenges**

#### \* Refresh

Difficult to build high-aspect ratio cell capacitors decreasing cell capacitance
THE MEMORY FORUM 2014

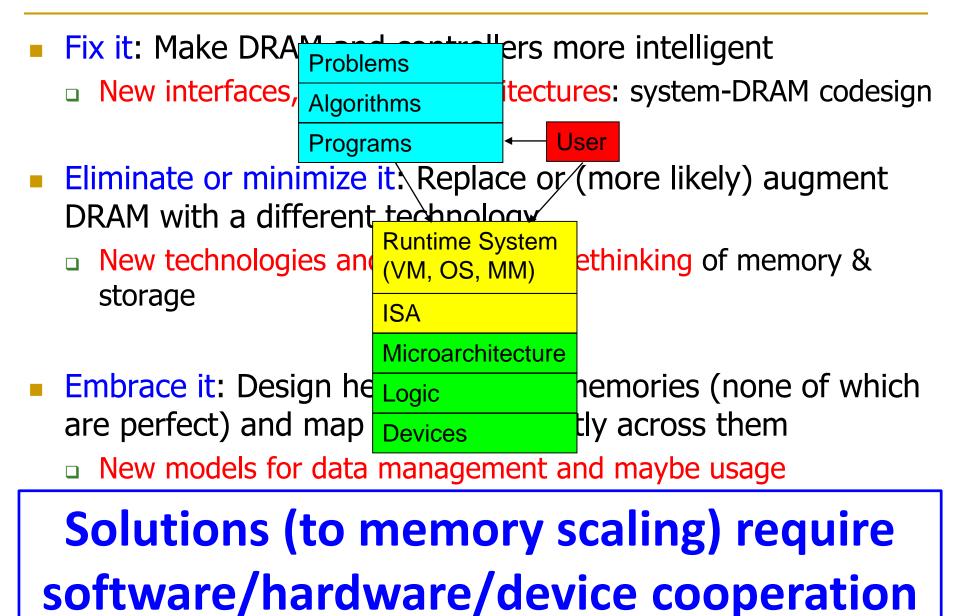
## Co-Architecting Controllers and DRAM to Enhance DRAM Process Scaling

Uksong Kang, Hak-soo Yu, Churoo Park, \*Hongzhong Zheng, \*\*John Halbert, \*\*Kuljit Bains, SeongJin Jang, and Joo Sun Choi



Samsung Electronics, Hwasung, Korea / \*Samsung Electronics, San Jose / \*\*Intel

### How Do We Solve The Problem?



### Solution 1: Fix DRAM

- Overcome DRAM shortcomings with
  - System-DRAM co-design
  - Novel DRAM architectures, interface, functions
  - Better waste management (efficient utilization)
- Key issues to tackle
  - Enable reliability at low cost
  - Reduce energy
  - Improve latency and bandwidth
  - Reduce waste (capacity, bandwidth, latency)
  - Enable computation close to data

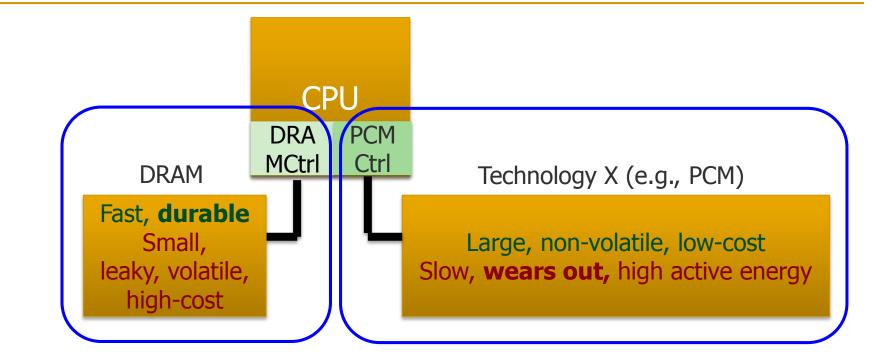
### Solution 1: Fix DRAM

- Liu+, "RAIDR: Retention-Aware Intelligent DRAM Refresh," ISCA 2012.
- Kim+, "A Case for Exploiting Subarray-Level Parallelism in DRAM," ISCA 2012.
- Lee+, "Tiered-Latency DRAM: A Low Latency and Low Cost DRAM Architecture," HPCA 2013.
- Liu+, "An Experimental Study of Data Retention Behavior in Modern DRAM Devices," ISCA 2013.
- Seshadri+, "RowClone: Fast and Efficient In-DRAM Copy and Initialization of Bulk Data," MICRO 2013.
- Pekhimenko+, "Linearly Compressed Pages: A Main Memory Compression Framework," MICRO 2013.
- Chang+, "Improving DRAM Performance by Parallelizing Refreshes with Accesses," HPCA 2014.
- Khan+, "The Efficacy of Error Mitigation Techniques for DRAM Retention Failures: A Comparative Experimental Study," SIGMETRICS 2014.
- Luo+, "Characterizing Application Memory Error Vulnerability to Optimize Data Center Cost," DSN 2014.
- Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.
- Lee+, "Adaptive-Latency DRAM: Optimizing DRAM Timing for the Common-Case," HPCA 2015.
- Qureshi+, "AVATAR: A Variable-Retention-Time (VRT) Aware Refresh for DRAM Systems," DSN 2015.
- Meza+, "Revisiting Memory Errors in Large-Scale Production Data Centers: Analysis and Modeling of New Trends from the Field," DSN 2015.
- Kim+, "Ramulator: A Fast and Extensible DRAM Simulator," IEEE CAL 2015.
- Seshadri+, "Fast Bulk Bitwise AND and OR in DRAM," IEEE CAL 2015.
- Ahn+, "A Scalable Processing-in-Memory Accelerator for Parallel Graph Processing," ISCA 2015.
- Ahn+ "PIM-Enabled Instructions: A Low-Overhead, Locality-Aware Processing-in-Memory Architecture," ISCA 2015.
- Avoid DRAM:
  - Seshadri+, "The Evicted-Address Filter: A Unified Mechanism to Address Both Cache Pollution and Thrashing," PACT 2012.
  - Pekhimenko+, "Base-Delta-Immediate Compression: Practical Data Compression for On-Chip Caches," PACT 2012.
  - Seshadri+, "The Dirty-Block Index," ISCA 2014.
  - Pekhimenko+, "Exploiting Compressed Block Size as an Indicator of Future Reuse," HPCA 2015.
  - Vijaykumar+, "A Case for Core-Assisted Bottleneck Acceleration in GPUs: Enabling Flexible Data Compression with Assist Warps," ISCA 2015.

# Solution 2: Emerging Memory Technologies

- Some emerging resistive memory technologies seem more scalable than DRAM (and they are non-volatile)
- Example: Phase Change Memory
  - Expected to scale to 9nm (2022 [ITRS])
  - Expected to be denser than DRAM: can store multiple bits/cell
- But, emerging technologies have shortcomings as well
   Can they be enabled to replace/augment/surpass DRAM?
- Lee+, "Architecting Phase Change Memory as a Scalable DRAM Alternative," ISCA'09, CACM'10, Micro'10.
- Meza+, "Enabling Efficient and Scalable Hybrid Memories," IEEE Comp. Arch. Letters 2012.
- Yoon, Meza+, "Row Buffer Locality Aware Caching Policies for Hybrid Memories," ICCD 2012.
- Kultursay+, "Evaluating STT-RAM as an Energy-Efficient Main Memory Alternative," ISPASS 2013.
- Meza+, "A Case for Efficient Hardware-Software Cooperative Management of Storage and Memory," WEED 2013.
- Lu+, "Loose Ordering Consistency for Persistent Memory," ICCD 2014.
- Zhao+, "FIRM: Fair and High-Performance Memory Control for Persistent Memory Systems," MICRO 2014.
- Yoon, Meza+, "Efficient Data Mapping and Buffering Techniques for Multi-Level Cell Phase-Change Memories," ACM TACO 2014.

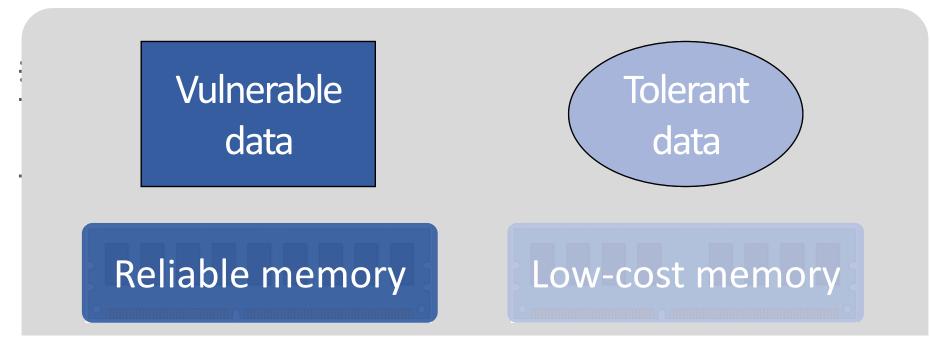
### Solution 3: Hybrid Memory Systems



### Hardware/software manage data allocation and movement to achieve the best of multiple technologies

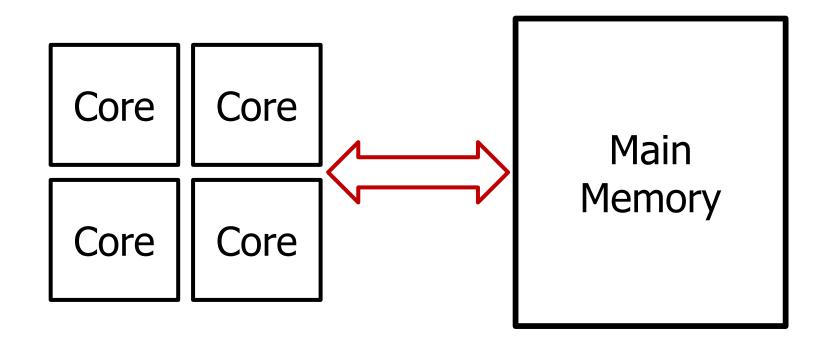
Meza+, "Enabling Efficient and Scalable Hybrid Memories," IEEE Comp. Arch. Letters, 2012. Yoon, Meza et al., "Row Buffer Locality Aware Caching Policies for Hybrid Memories," ICCD 2012 Best Paper Award.

### Exploiting Memory Error Tolerance with Hybrid Memory Systems



On Microsoft's Web Search workload Reduces server hardware cost by 4.7 % Achieves single server availability target of 99.90 % Heterogeneous-Reliability Memory [DSN 2014]

### An Orthogonal Issue: Memory Interference

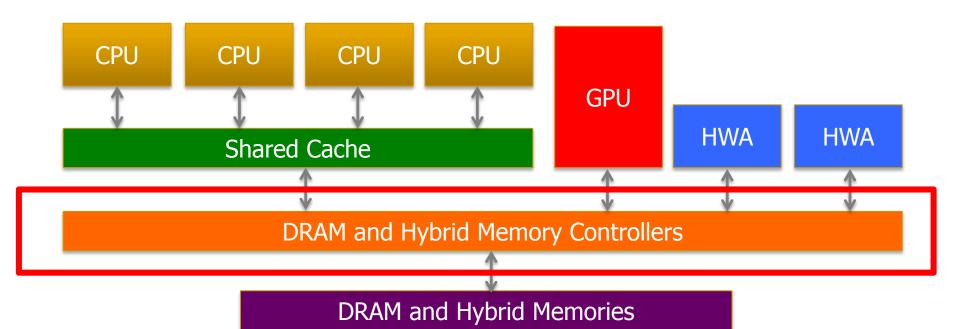


Cores' interfere with each other when accessing shared main memory

### An Orthogonal Issue: Memory Interference

- Problem: Memory interference between cores is uncontrolled
  - $\rightarrow$  unfairness, starvation, low performance
  - $\rightarrow$  uncontrollable, unpredictable, vulnerable system
- Solution: QoS-Aware Memory Systems
  - Hardware designed to provide a configurable fairness substrate
    - Application-aware memory scheduling, partitioning, throttling
  - Software designed to configure the resources to satisfy different QoS goals
- QoS-aware memory systems can provide predictable performance and higher efficiency

### Goal: Predictable Performance in Complex Systems



- Heterogeneous agents: CPUs, GPUs, and HWAs
- Main memory interference between CPUs, GPUs, HWAs

How to allocate resources to heterogeneous agents to mitigate interference and provide predictable performance?

### Strong Memory Service Guarantees

- Goal: Satisfy performance/SLA requirements in the presence of shared main memory, heterogeneous agents, and hybrid memory/storage
- Approach:
  - Develop techniques/models to accurately estimate the performance loss of an application/agent in the presence of resource sharing
  - Develop mechanisms (hardware and software) to enable the resource partitioning/prioritization needed to achieve the required performance levels for all applications
  - □ All the while providing high system performance
- Example work: Subramanian et al., "MISE: Providing Performance Predictability and Improving Fairness in Shared Main Memory Systems," HPCA 2013.

# Some Promising Directions

### New memory architectures

- Rethinking DRAM and flash memory
- A lot of hope in fixing DRAM

### Enabling emerging NVM technologies

- Hybrid memory systems
- Single-level memory and storage
- A lot of hope in hybrid memory systems and single-level stores

### System-level memory/storage QoS

A lot of hope in designing a predictable system

# We did not cover the remaining slides in Recitation 2.



- Major Trends Affecting Main Memory
- The Memory Scaling Problem and Solution Directions
  - New Memory Architectures
  - Enabling Emerging Technologies
- How Can We Do Better?
- Summary

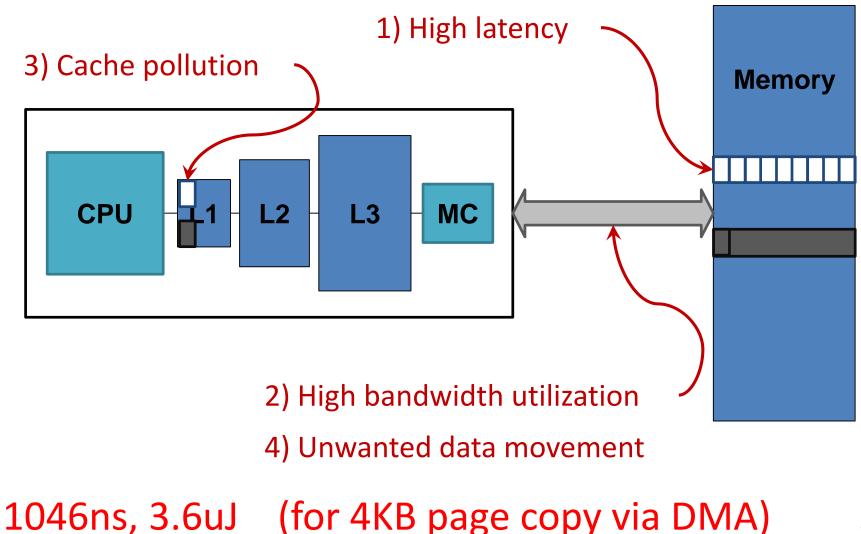
# Rethinking DRAM

In-Memory Computation

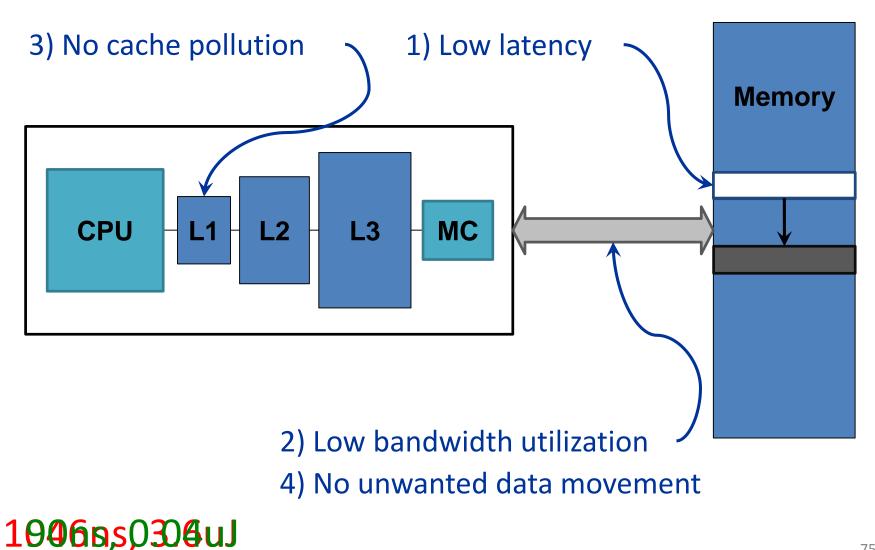
- Refresh
- Reliability
- Latency
- Bandwidth
- Energy
- Memory Compression

#### SAFARI

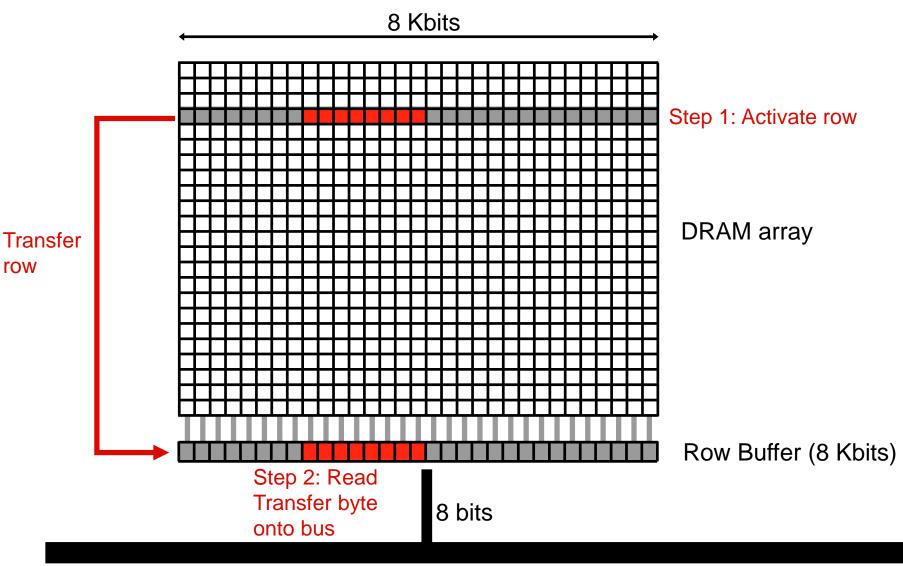
#### Today's Memory: Bulk Data Copy



Future: RowClone (In-Memory Copy)

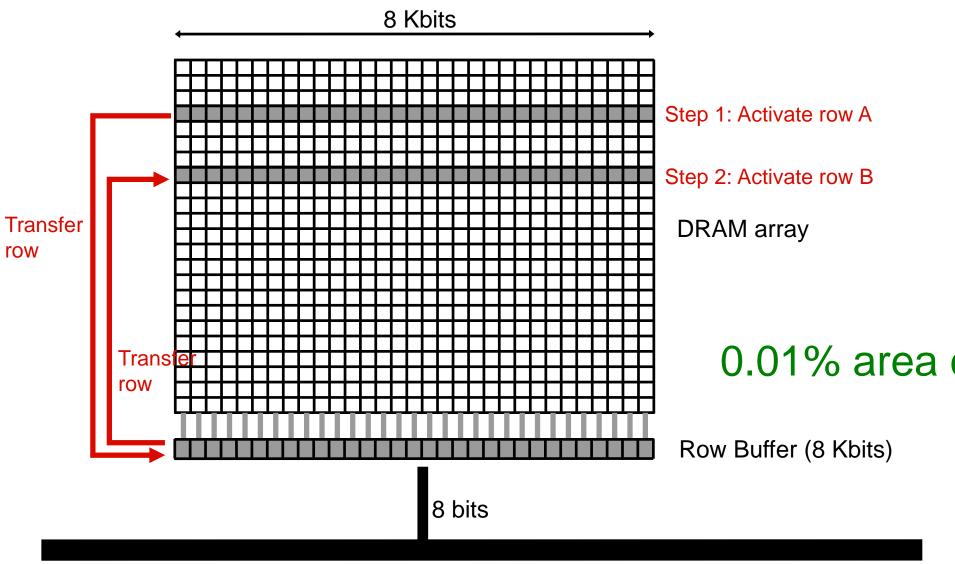


#### DRAM Subarray Operation (load one byte)



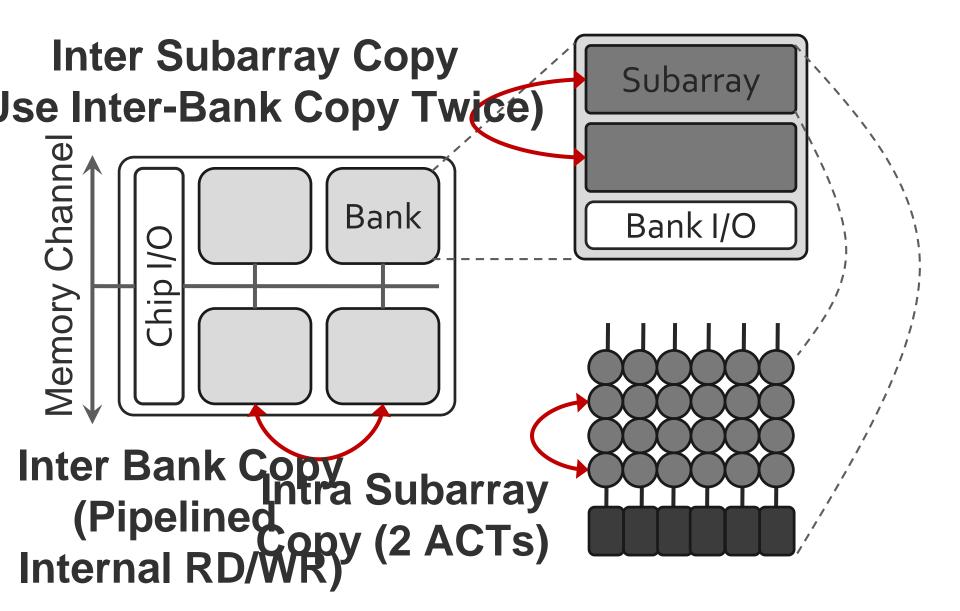
Data Bus

#### RowClone: In-DRAM Row Copy

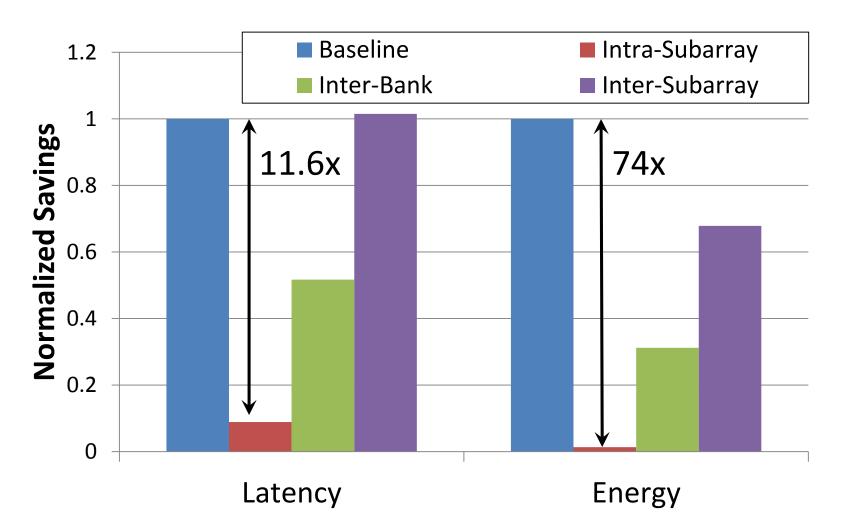


Data Bus

#### Generalized RowClone

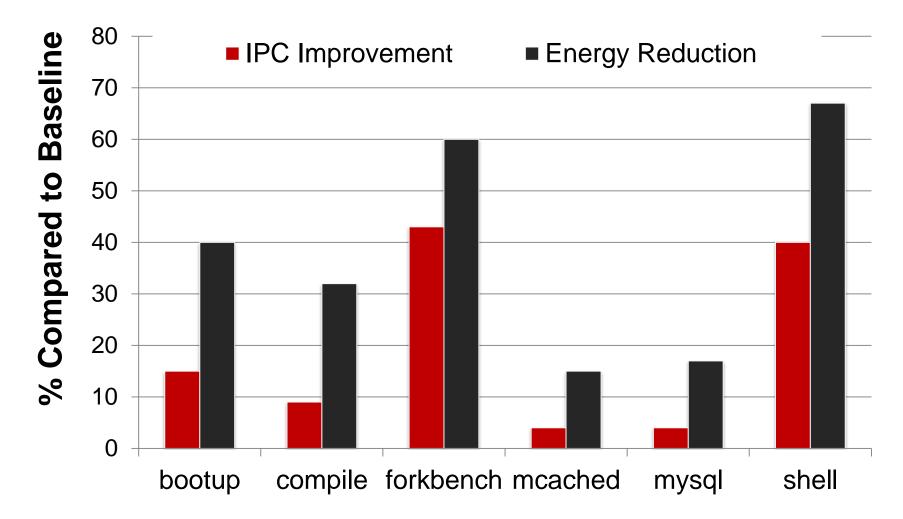


#### RowClone: Latency and Energy Savings

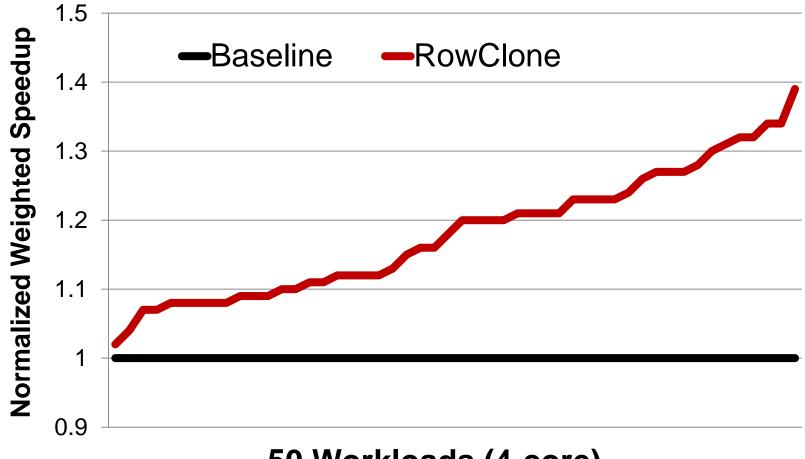


Seshadri et al., "RowClone: Fast and Efficient In-DRAM Copy and Initialization of Bulk Data," MICRO 2013.

#### RowClone: Application Performance

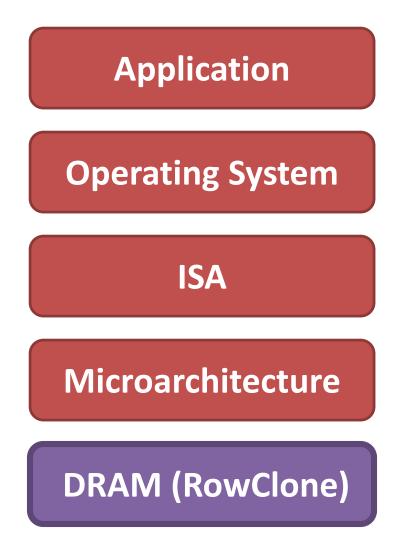


#### RowClone: Multi-Core Performance



#### 50 Workloads (4-core)

# End-to-End System Design



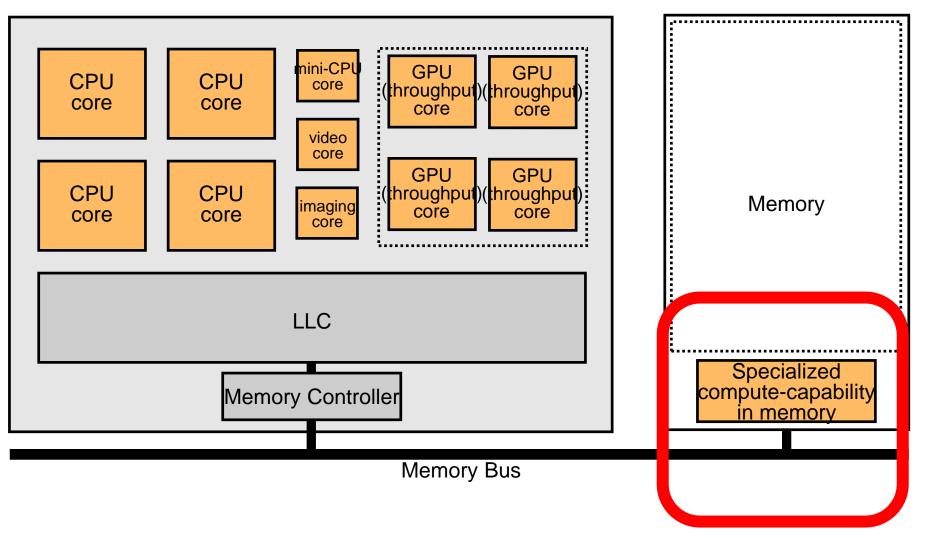
How to communicate occurrences of bulk copy/initialization across layers?

How to ensure cache coherence?

How to maximize latency and energy savings?

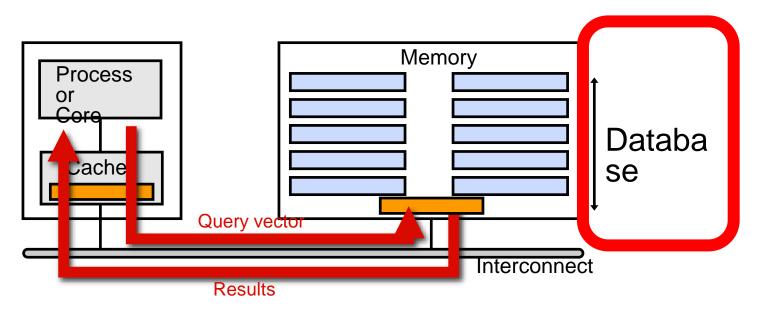
How to handle data reuse?

#### Goal: Ultra-Efficient Processing Near Data



#### Memory similar to a "conventional" acceleration

#### Enabling In-Memory Search



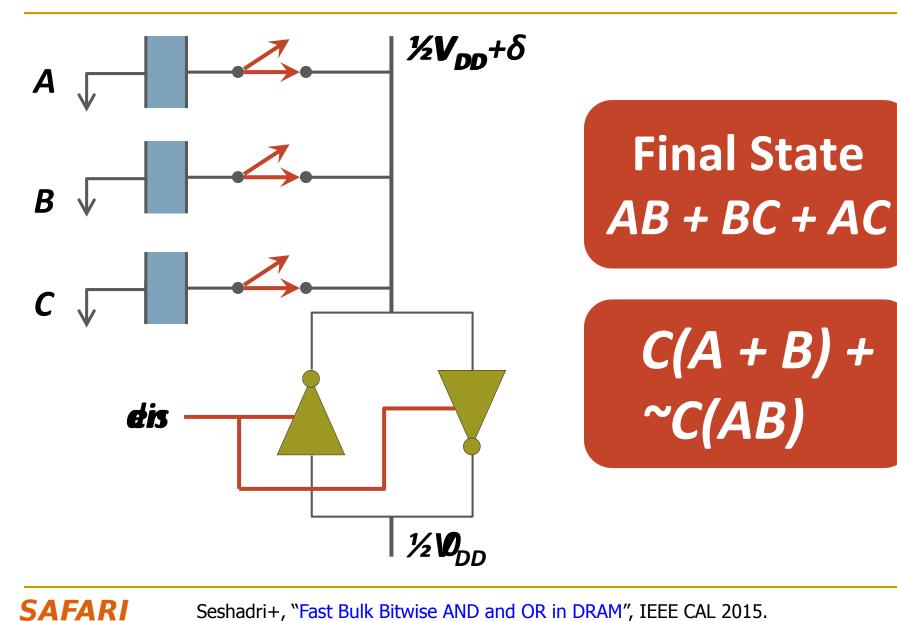
- What is a flexible and scalable memory interface?
- What is the right partitioning of computation capability?
- What is the right low-cost memory substrate?
- What memory technologies are the best

#### Enabling In-Memory Computation

DRAM Support	Cache Coherence	Virtual Memory Support
RowClone (MICRO 2013)	Dirty-Block Index (ISCA 2014)	Page Overlays (ISCA 2015)
In-DRAM Gather Scatter	Non-contiguous Cache lines	Gathered Pages
In-DRAM Bitwise Operations (IEEE CAL 2015)	?	?

#### SAFARI

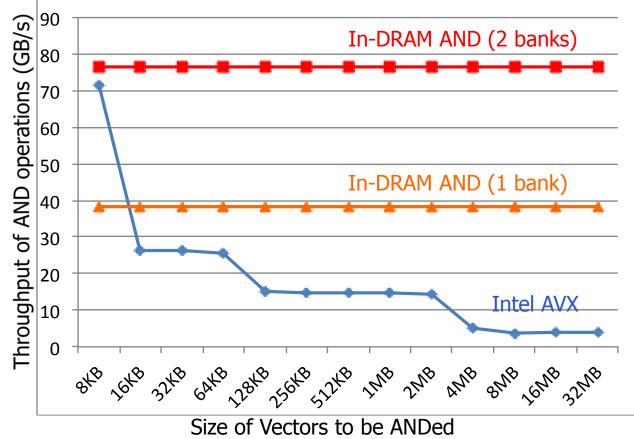
#### In-DRAM AND/OR: Triple Row Activation



#### Seshadri+, "Fast Bulk Bitwise AND and OR in DRAM", IEEE CAL 2015.

#### In-DRAM AND/OR Results

- 20X improvement in AND/OR throughput vs. Intel AVX
- 50.5X reduction in memory energy consumption
- At least 30% performance improvement in range queries



Seshadri+, "Fast Bulk Bitwise AND and OR in DRAM", IEEE CAL 2015.

# Rethinking DRAM

In-Memory Computation



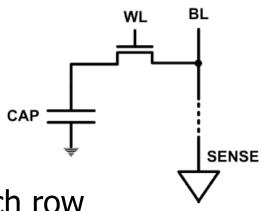


- Latency
- Bandwidth
- Energy
- Memory Compression

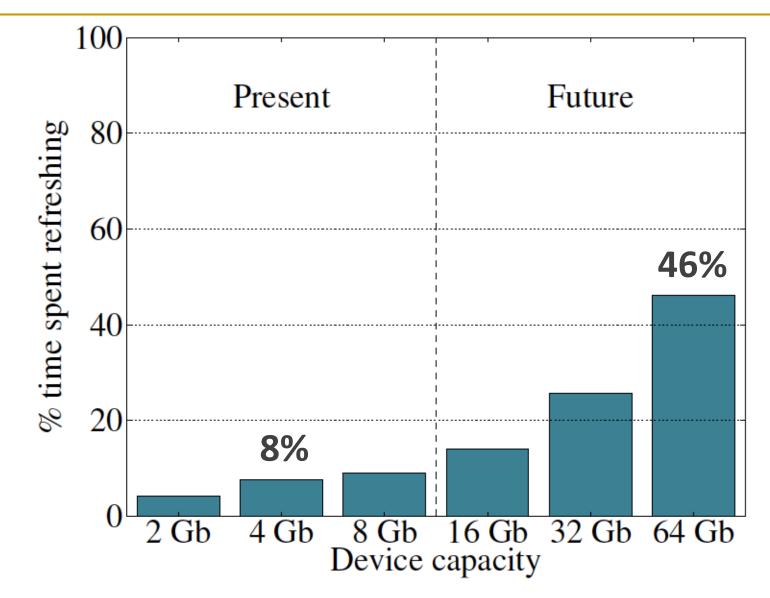
#### SAFARI

#### DRAM Refresh

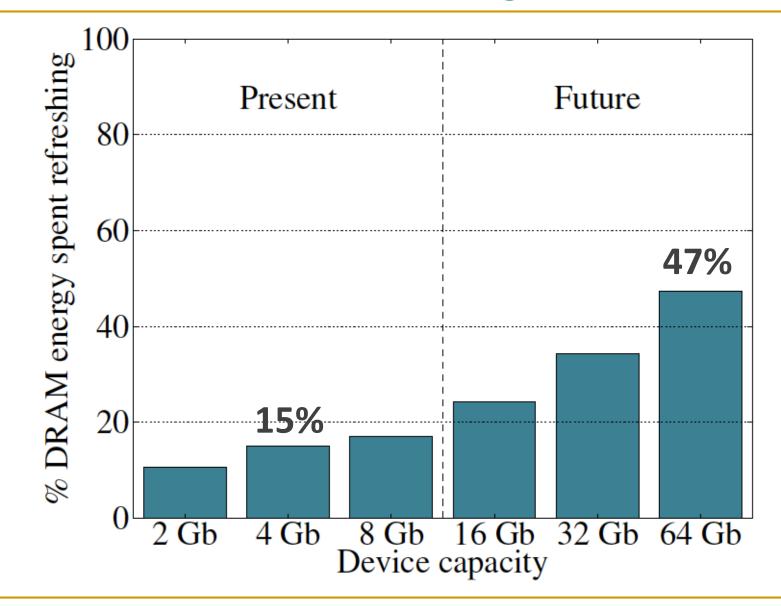
- DRAM capacitor charge leaks over time
- The memory controller needs to refresh each row periodically to restore charge
  - Activate each row every N ms
  - Typical N = 64 ms
- Downsides of refresh
  - -- Energy consumption: Each refresh consumes energy
  - -- Performance degradation: DRAM rank/bank unavailable while refreshed
  - -- QoS/predictability impact: (Long) pause times during refresh
  - -- Refresh rate limits DRAM capacity scaling



#### Refresh Overhead: Performance



#### Refresh Overhead: Energy



#### Retention Time Profile of DRAM

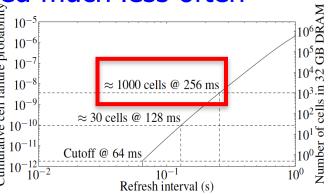
# 64-128ms >256ms

# 128-256ms

# RAIDR: Eliminating Unnecessary Refreshes

- Observation: Most DRAM rows can be refreshed much less often without losing data [Kim+, EDL'09][Liu+ ISCA'13] 10
- Key idea: Refresh rows containing weak cells more frequently, other rows less frequently

1. Profiling: Profile retention time of all rows



Auto RAIDR

8 Gb

20

0

4 Gb

50%

64 Gb

32 Gb

16 Gb

Device capacity

2. Binning: Store rows into bins by retention time in memory controller

*Efficient storage with Bloom Filters* (only 1.25KB for 32GB memory)

3. Refreshing: Memory controller refreshes rows in different bins at

- - Benefits increase with DRAM capacity

Liu et al., "RAIDR: Retention-Aware Intelligent DRAM Refresh," ISCA 2012.

# Going Forward (for DRAM and Flash)

#### How to find out weak memory cells/rows

- Liu+, "An Experimental Study of Data Retention Behavior in Modern DRAM Devices: Implications for Retention Time Profiling Mechanisms", ISCA 2013.
- Khan+, "The Efficacy of Error Mitigation Techniques for DRAM Retention Failures: A Comparative Experimental Study," SIGMETRICS 2014.

#### Low-cost system-level tolerance of memory errors

- Luo+, "Characterizing Application Memory Error Vulnerability to Optimize Data Center Cost," DSN 2014.
- Cai+, "Error Analysis and Retention-Aware Error Management for NAND Flash Memory," Intel Technology Journal 2013.
- Cai+, "Neighbor-Cell Assisted Error Correction for MLC NAND Flash Memories," SIGMETRICS 2014.

#### Tolerating cell-to-cell interference at the system level

- Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.
- Cai+, "Program Interference in MLC NAND Flash Memory: Characterization, Modeling, and Mitigation," ICCD 2013.

#### SAFARI

# Experimental DRAM Testing Infrastructure

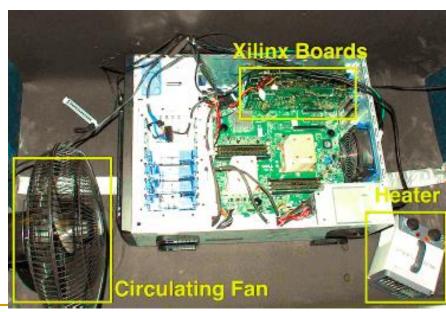


Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors (Kim et al., ISCA 2014)

Adaptive-Latency DRAM: Optimizing DRAM Timing for the Common-Case (Lee et al., HPCA 2015)

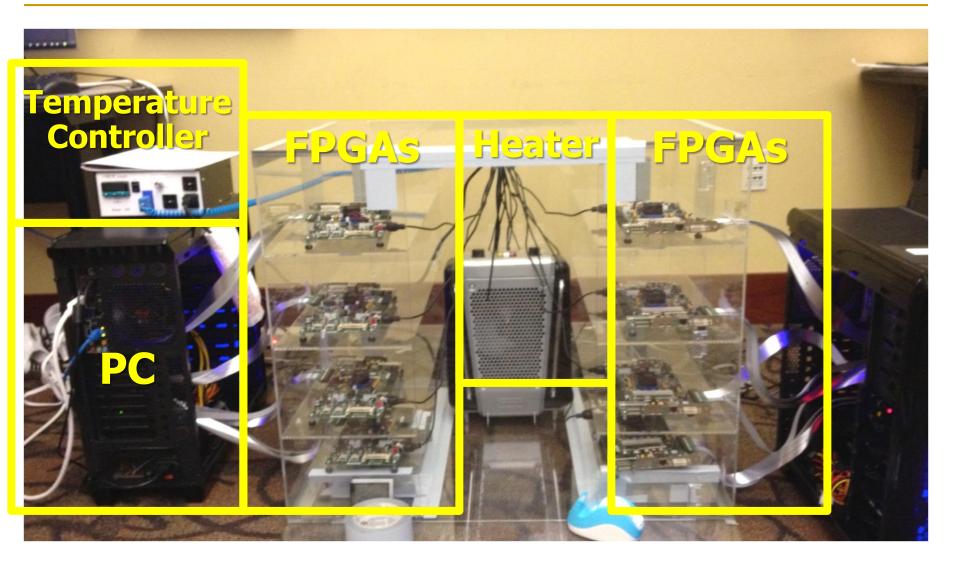
AVATAR: A Variable-Retention-Time (VRT) Aware Refresh for DRAM Systems (Qureshi et al., DSN 2015) An Experimental Study of Data Retention Behavior in Modern DRAM Devices: Implications for Retention Time Profiling Mechanisms (Liu et al., ISCA 2013)

The Efficacy of Error Mitigation Techniques for DRAM Retention Failures: A Comparative Experimental Study (Khan et al., SIGMETRICS 2014)



#### SAFARI

#### Experimental Infrastructure (DRAM)



#### SAFARI

Kim+, "Flipping Bits in Memory Without Accessing Them: An Experimental Study of DRAM Disturbance Errors," ISCA 2014.

#### The Efficacy of Error Mitigation Techniques for DRAM Retention Failures: A Comparative Experimental Study

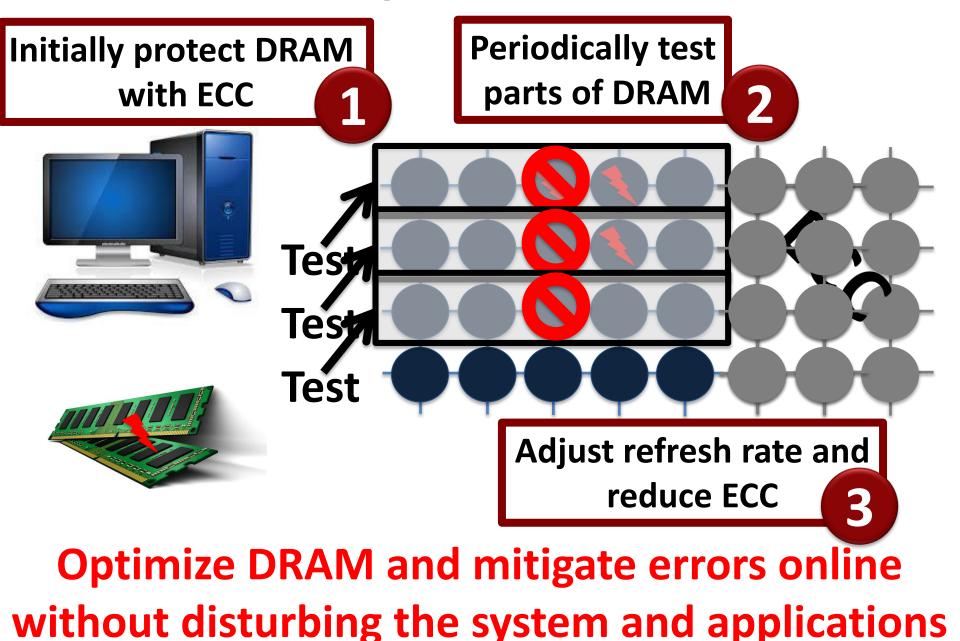
Samira Khan<sup>†</sup>\* samirakhan@cmu.edu Donghyuk Lee<sup>†</sup> donghyuk1@cmu.edu Yoongu Kim<sup>+</sup> yoongukim@cmu.edu

Alaa R. Alameldeen\* Chris Wilkerson\* alaa.r.alameldeen@intel.com chris.wilkerson@intel.com

Onur Mutlu<sup>†</sup> onur@cmu.edu

<sup>†</sup>Carnegie Mellon University \*Intel Labs

#### Online Profiling of DRAM In the Field



# Rethinking DRAM

- In-Memory Computation
- Refresh
- Reliability

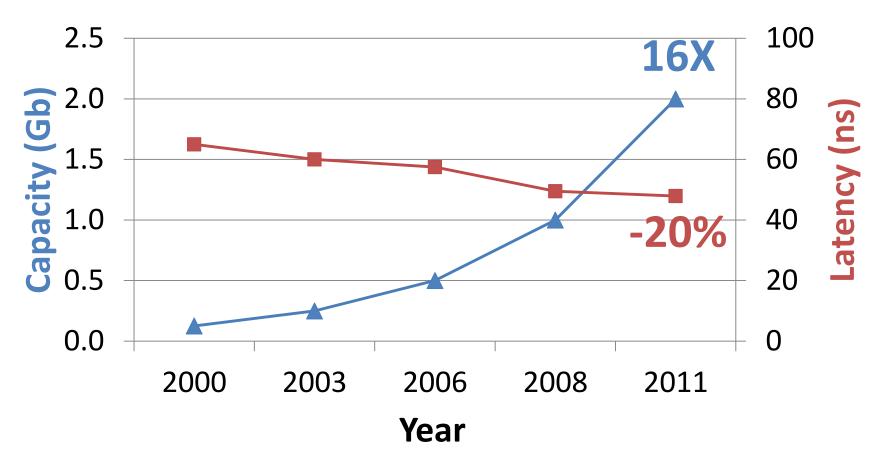


- Bandwidth
- Energy
- Memory Compression

#### SAFARI

#### **DRAM Latency-Capacity Trend**

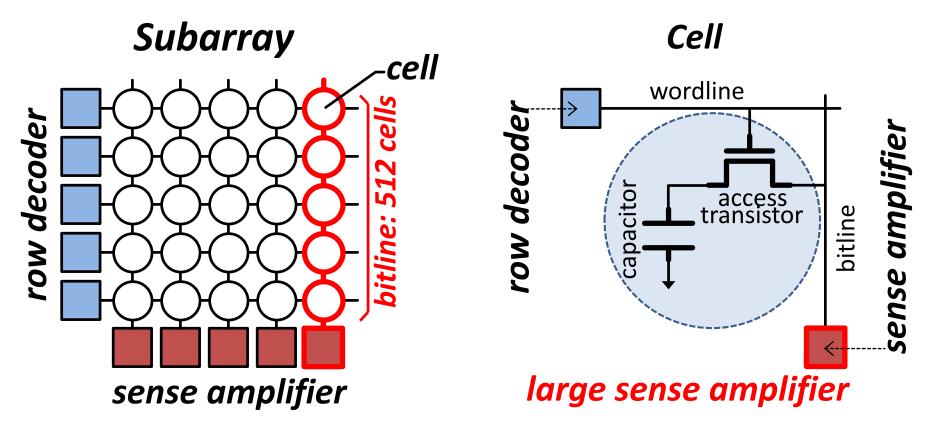
Capacity -Latency (tRC)



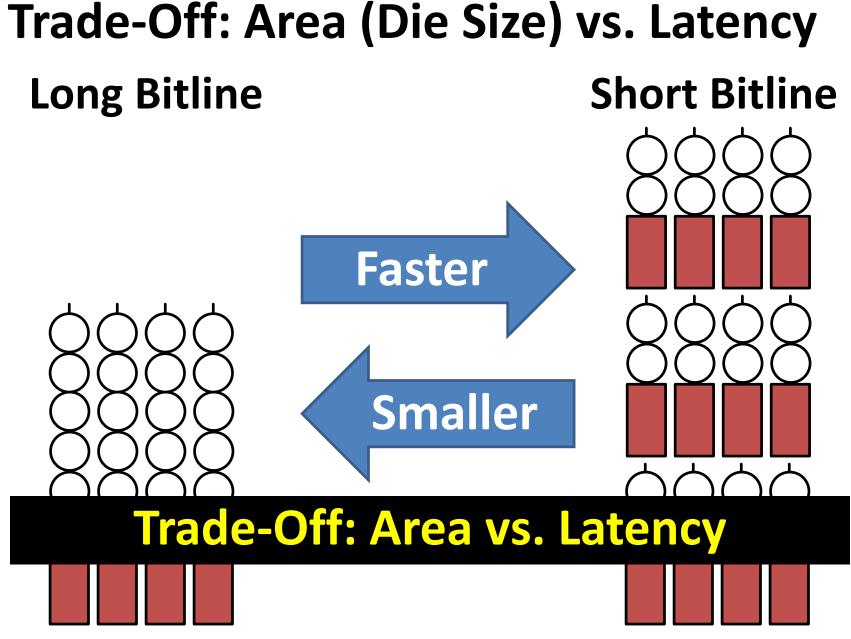
DRAM latency continues to be a critical bottleneck, especially for response time-sensitive<sup>100</sup>

# What Causes the Long Latency? **DRAM** Chip subarray Subarray 0/ 1/0 channel **1** DRAM Latency - (Subarray Latency + II/O Latency Dominant

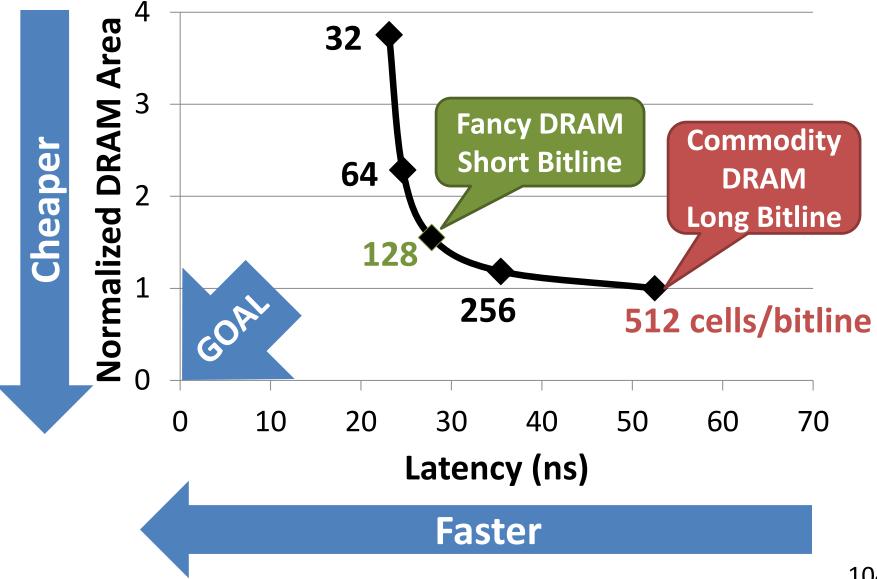
# Why is the Subarray So Slow?



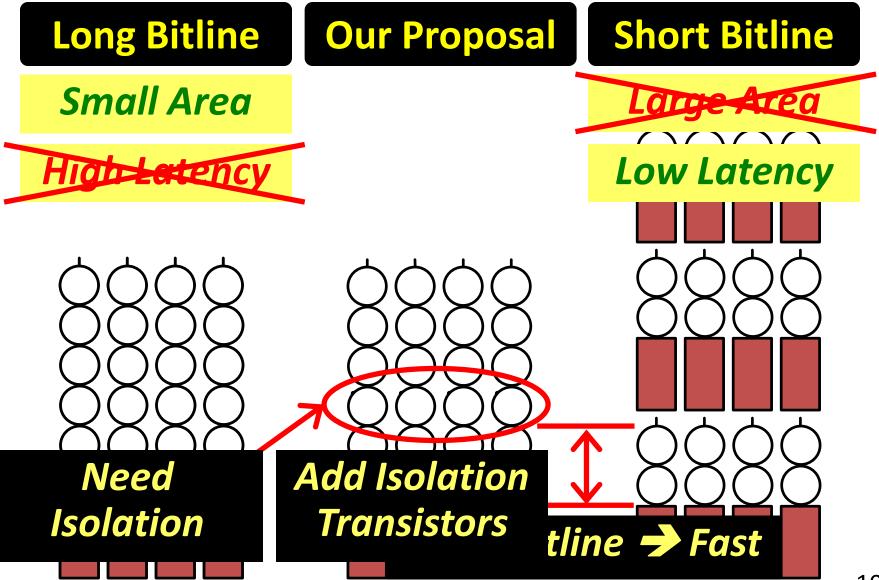
- Long bitline
  - Amortizes sense amplifier cost  $\rightarrow$  Small area
  - Large bitline capacitance → High latency & power



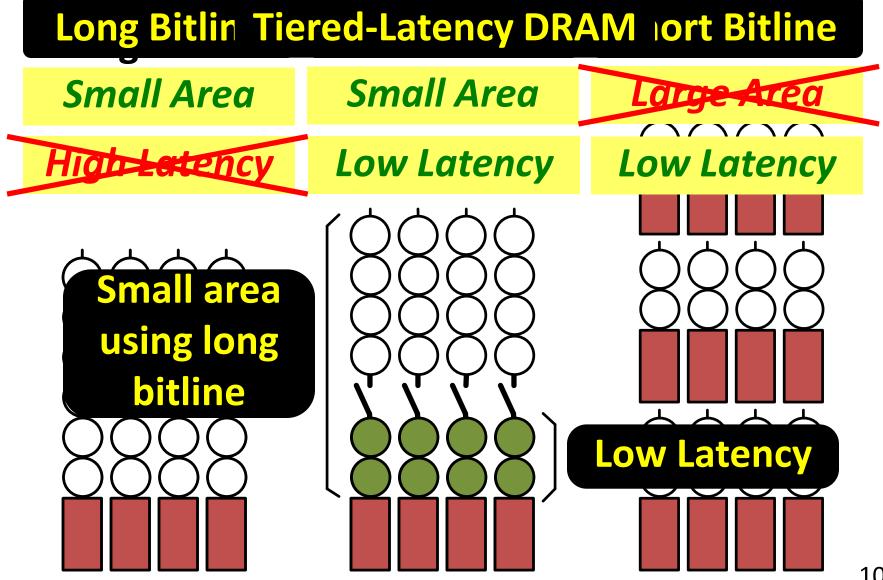
#### Trade-Off: Area (Die Size) vs. Latency



# **Approximating the Best of Both Worlds**

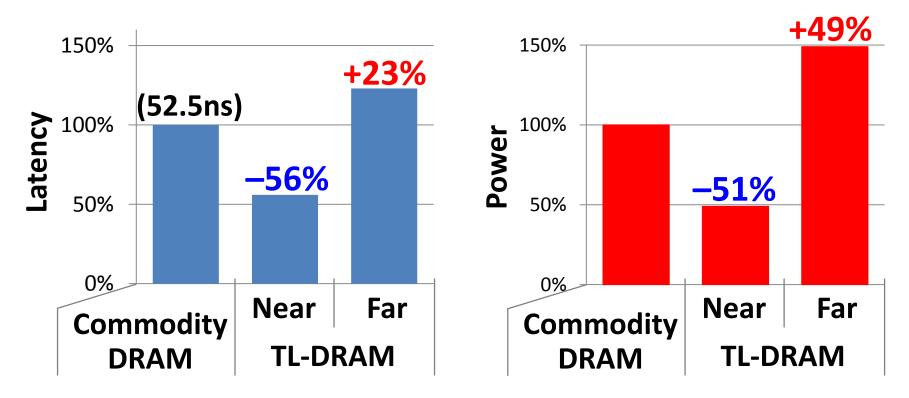


### **Approximating the Best of Both Worlds**



# Commodity DRAM vs. TL-DRAM [HPCA 2013]

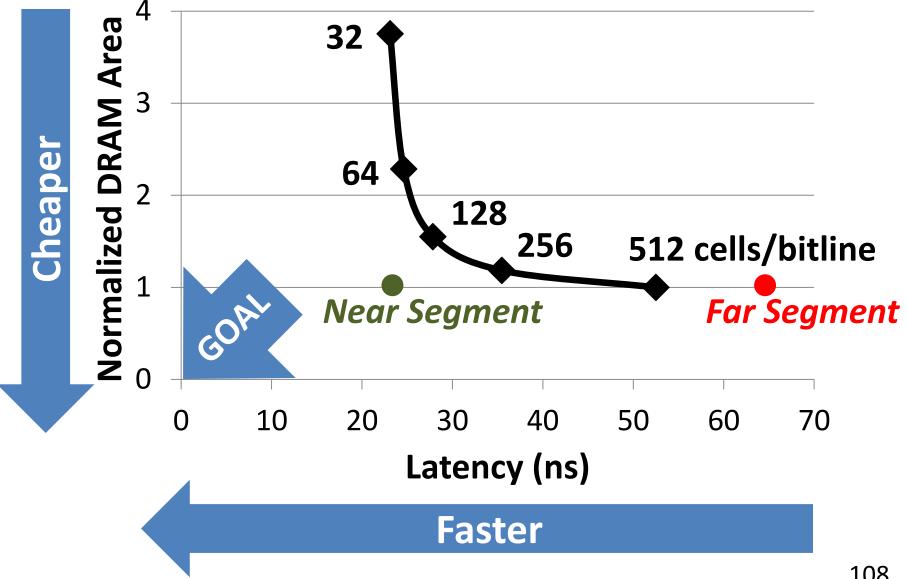
• DRAM Latency (tRC) • DRAM Power



#### DRAM Area Overhead

**~3%**: mainly due to the isolation transistors

#### Trade-Off: Area (Die-Area) vs. Latency



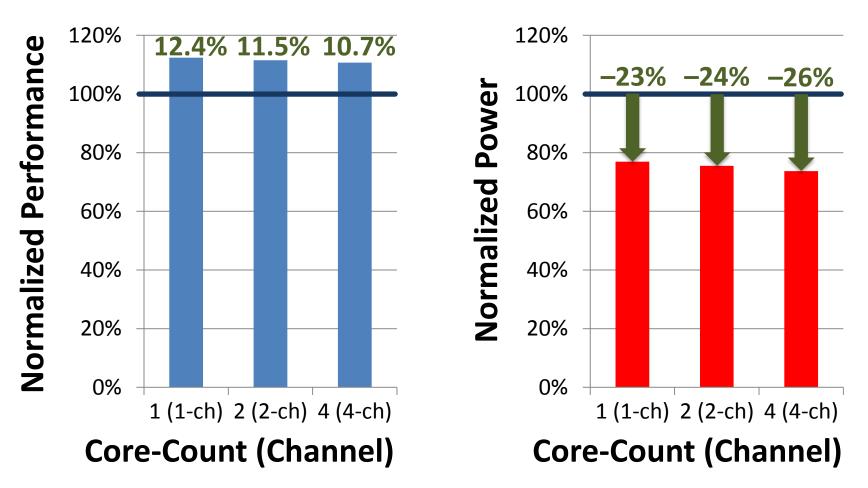
## Leveraging Tiered-Latency DRAM

- TL-DRAM is a *substrate* that can be leveraged by the hardware and/or software
- Many potential uses

 Use near segment as hardware-managed *inclusive* cache to far segment

- 2. Use near segment as hardware-managed *exclusive* cache to far segment
- 3. Profile-based page mapping by operating system
- 4. Simply replace DRAM with TL-DRAM

## **Performance & Power Consumption**



# Using near segment as a cache improves performance and reduces power consumption

Lee+, "Tiered-Latency DRAM: A Low Latency and Low Cost DRAM Architecture," HPCA 2013.

### What Else Causes the Long DRAM Latency?

#### Conservative timing margins!

DRAM timing parameters are set to cover the worst case

#### Worst-case temperatures

- 85 degrees vs. common-case
- to enable a wide range of operating conditions
- Worst-case devices
  - DRAM cell with smallest charge across any acceptable device
  - to tolerate process variation at acceptable yield
- This leads to large timing margins for the common case

### Adaptive-Latency DRAM [HPCA 2015]

- Idea: Optimize DRAM timing for the common case
  - Current temperature
  - Current DRAM module
- Why would this reduce latency?
  - A DRAM cell can store much more charge in the common case (low temperature, strong cell) than in the worst case
  - More charge in a DRAM cell
    - $\rightarrow$  Faster sensing, charge restoration, precharging
    - $\rightarrow$  Faster access (read, write, refresh, ...)

**SAFARI** Lee+, "Adaptive-Latency DRAM: Optimizing DRAM Timing for the Common-Case,"112 HPCA 2015.

### AL-DRAM

- Key idea
  - Optimize DRAM timing parameters online
- Two components
  - DRAM manufacturer provides multiple sets of reliable DRAM timing parameters at different temperatures for each DIMM
    - System monitors DRAM temperature & uses appropriate DRAM timing parameters

**SAFARI** Lee+, "Adaptive-Latency DRAM: Optimizing DRAM Timing for the Common-Case," HPCA 113 2015.

## Latency Reduction Summary of 115 DIMMs

- Latency reduction for read & write (55°C)
  - Read Latency: **32.7%**
  - Write Latency: 55.1%
- Latency reduction for each timing parameter (55°C)
  - Sensing: **17.3%**
  - Restore: 37.3% (read), 54.8% (write)
  - Precharge: **35.2%**

**SAFARI** Lee+, "Adaptive-Latency DRAM: Optimizing DRAM Timing for the Common-Case," HPCA 114 2015.

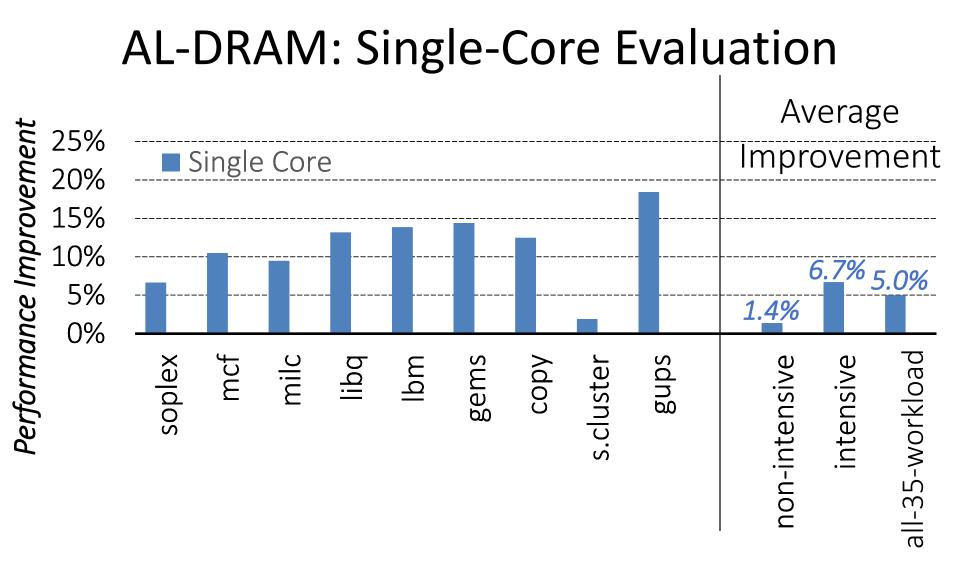
### **AL-DRAM: Real System Evaluation**

• System

### - CPU: AMD 4386 ( 8 Cores, 3.1GHz, 8MB LLC)

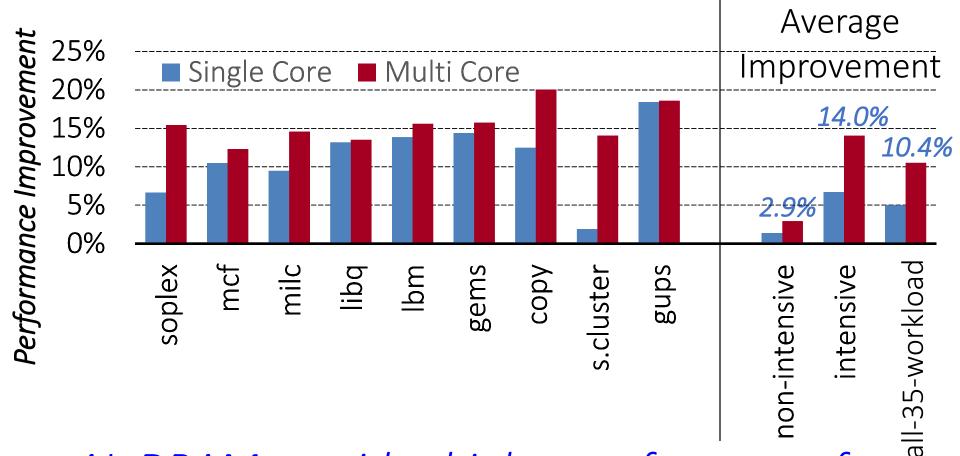
D18F2x200_dct[0]_mp[1:0] DDR3 DRAM Timing 0		
Reset: (	)F05_0505h. Se	ee 2.9.3 [DCT Configuration Registers].
Bits	Description	
31:30	Reserved.	
29:24		ve strobe. Read-write. BIOS: See 2.9.7.5 [SPD ROM-Based Configuration]. Specifies ime in memory clock cycles from an activate command to a precharge command, both p select bank. <u>Description</u> Reserved <tras> clocks Reserved</tras>
23:21	Reserved.	

20:16 **Trp: row precharge time**. Read-write. BIOS: See 2.9.7.5 [SPD ROM-Based Configuration]. Specifies the minimum time in memory clock cycles from a precharge command to an activate command or auto refresh command, both to the same bank.



AL-DRAM improves performance on a real system

## AL-DRAM: Multi-Core Evaluation



AL-DRAM provides higher performance for <sup>®</sup> multi-programmed & multi-threaded workloads SAFARI

## Rethinking DRAM

- In-Memory Computation
- Refresh
- Reliability
- Latency





Memory Compression

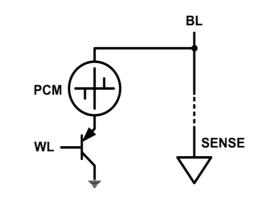


- Major Trends Affecting Main Memory
- The Memory Scaling Problem and Solution Directions
  - New Memory Architectures
  - Enabling Emerging Technologies
- How Can We Do Better?
- Summary

#### 120

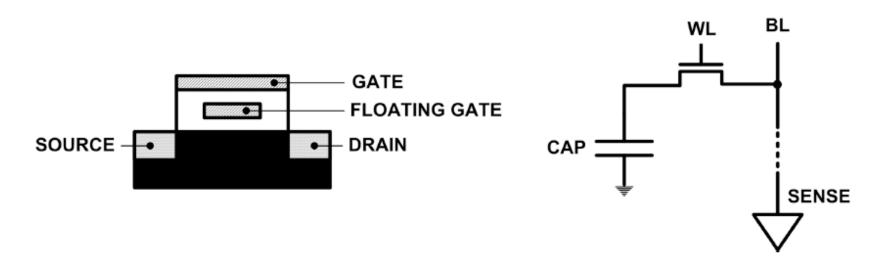
### Solution 2: Emerging Memory Technologies

- Some emerging resistive memory technologies seem more scalable than DRAM (and they are non-volatile)
- Example: Phase Change Memory
  - Data stored by changing phase of material
  - Data read by detecting material's resistance
  - Expected to scale to 9nm (2022 [ITRS])
  - Prototyped at 20nm (Raoux+, IBM JRD 2008)
  - Expected to be denser than DRAM: can store multiple bits/cell
- But, emerging technologies have (many) shortcomings
   Can they be enabled to replace/augment/surpass DRAM?



### Limits of Charge Memory

- Difficult charge placement and control
  - Flash: floating gate charge
  - DRAM: capacitor charge, transistor leakage
- Reliable sensing becomes difficult as charge storage unit size reduces



## Promising Resistive Memory Technologies

#### PCM

- Inject current to change material phase
- Resistance determined by phase

### STT-MRAM

- Inject current to change magnet polarity
- Resistance determined by polarity
- Memristors/RRAM/ReRAM
  - Inject current to change atomic structure
  - Resistance determined by atom distance

### Phase Change Memory: Pros and Cons

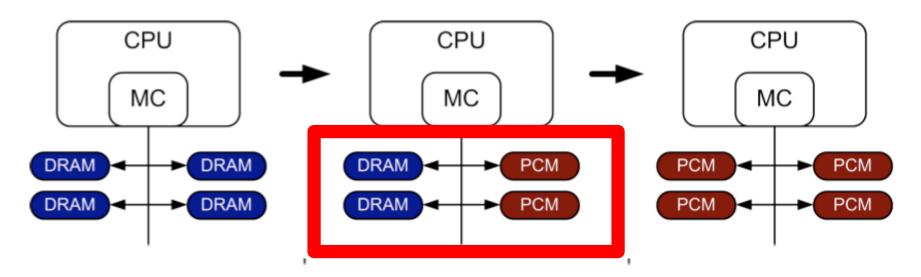
- Pros over DRAM
  - Better technology scaling (capacity and cost)
  - Non volatility
  - Low idle power (no refresh)

#### Cons

- Higher latencies: ~4-15x DRAM (especially write)
- □ Higher active energy: ~2-50x DRAM (especially write)
- Lower endurance (a cell dies after  $\sim 10^8$  writes)
- Reliability issues (resistance drift)
- Challenges in enabling PCM as DRAM replacement/helper:
  - Mitigate PCM shortcomings
  - □ Find the right way to place PCM in the system

## PCM-based Main Memory (I)

How should PCM-based (main) memory be organized?

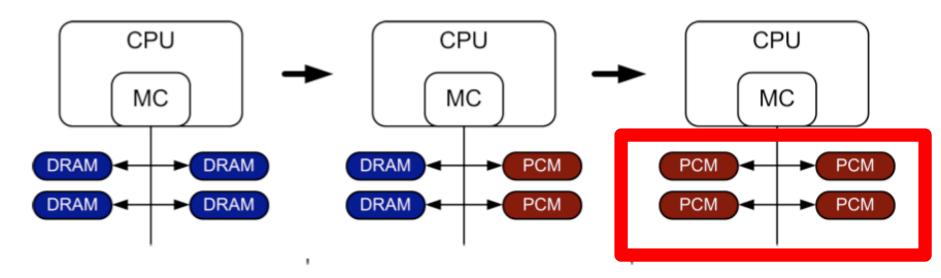


Hybrid PCM+DRAM [Qureshi+ ISCA'09, Dhiman+ DAC'09]:

How to partition/migrate data between PCM and DRAM

## PCM-based Main Memory (II)

How should PCM-based (main) memory be organized?



Pure PCM main memory [Lee et al., ISCA'09, Top Picks'10]:

 How to redesign entire hierarchy (and cores) to overcome PCM shortcomings

## An Initial Study: Replace DRAM with PCM

- Lee, Ipek, Mutlu, Burger, "Architecting Phase Change Memory as a Scalable DRAM Alternative," ISCA 2009.
  - Surveyed prototypes from 2003-2008 (e.g. IEDM, VLSI, ISSCC)
  - Derived "average" PCM parameters for F=90nm

### Density

▷ 9 - 12F<sup>2</sup> using BJT

▷ 1.5× DRAM

#### Endurance

▷ 1E+08 writes



#### Latency

50ns Rd, 150ns Wr

 $\triangleright$  4×, 12× DRAM

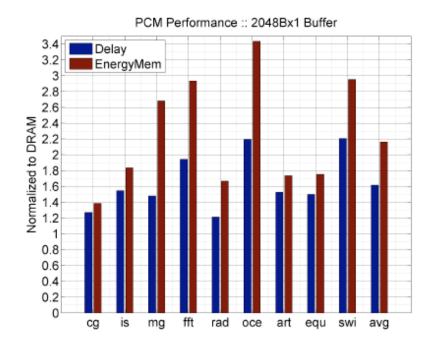
#### Energy

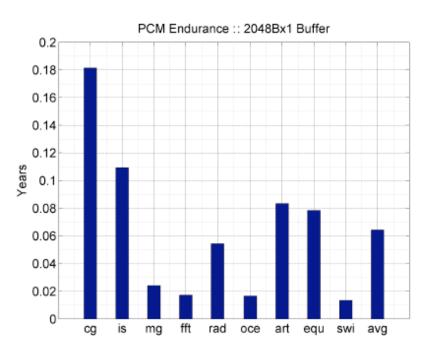
▷ 40µA Rd, 150µA Wr

 $\triangleright$  2×, 43× DRAM

### Results: Naïve Replacement of DRAM with PCM

- Replace DRAM with PCM in a 4-core, 4MB L2 system
- PCM organized the same as DRAM: row buffers, banks, peripherals
- 1.6x delay, 2.2x energy, 500-hour average lifetime

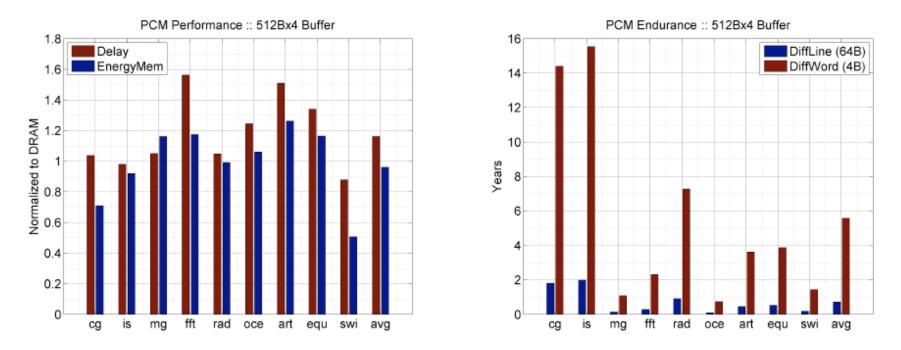




 Lee, Ipek, Mutlu, Burger, "Architecting Phase Change Memory as a Scalable DRAM Alternative," ISCA 2009.

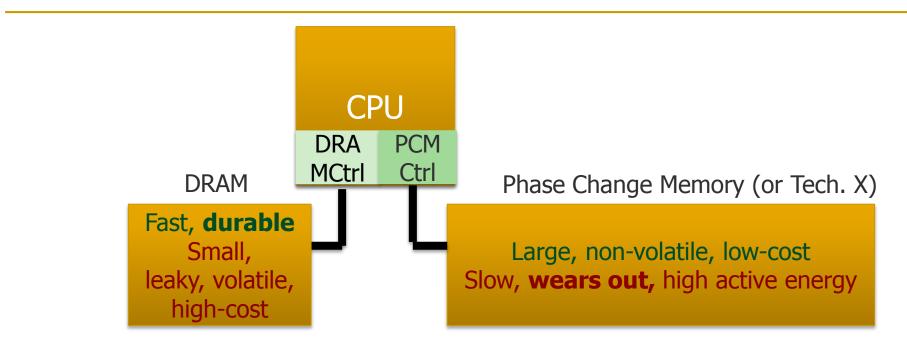
## Results: Architected PCM as Main Memory

- 1.2x delay, 1.0x energy, 5.6-year average lifetime
- Scaling improves energy, endurance, density



- Caveat 1: Worst-case lifetime is much shorter (no guarantees)
- Caveat 2: Intensive applications see large performance and energy hits
- Caveat 3: Optimistic PCM parameters?

### Solution 3: Hybrid Memory Systems

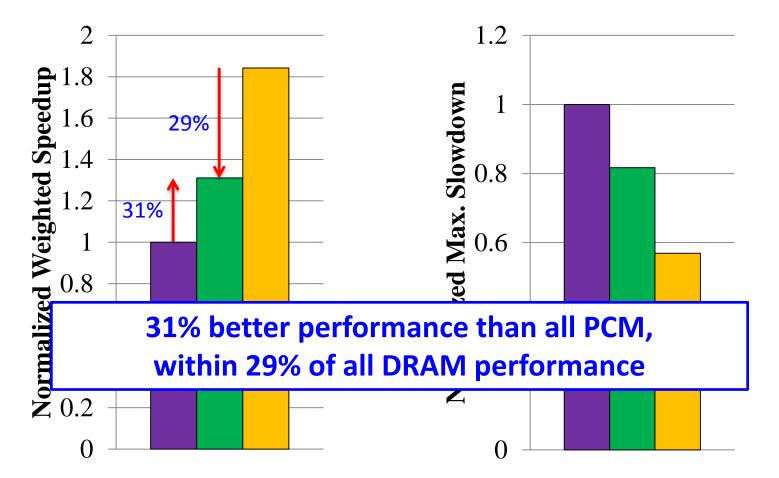


#### Hardware/software manage data allocation and movement to achieve the best of multiple technologies

Meza+, "Enabling Efficient and Scalable Hybrid Memories," IEEE Comp. Arch. Letters, 2012. Yoon+, "Row Buffer Locality Aware Caching Policies for Hybrid Memories," ICCD 2012 Best Paper Award.

## Hybrid vs. All-PCM/DRAM [ICCD'12]

■ 16GB PCM ■ RBLA-Dyn ■ 16GB DRAM



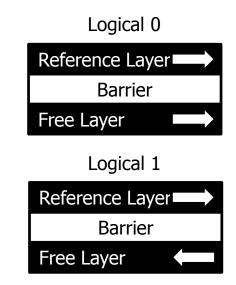
Yoon+, "Row Buffer Locality-Aware Data Placement in Hybrid Memories," ICCD 2012 Best Paper Award.

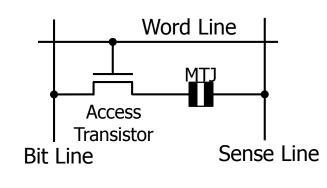
### STT-MRAM as Main Memory

- Magnetic Tunnel Junction (MTJ) device
  - Reference layer: Fixed magnetic orientation
  - □ Free layer: Parallel or anti-parallel
- Magnetic orientation of the free layer determines logical state of device
  - High vs. low resistance
- Write: Push large current through MTJ to change orientation of free layer
- Read: Sense current flow

SAFARI

 Kultursay et al., "Evaluating STT-RAM as an Energy-Efficient Main Memory Alternative," ISPASS 2013.



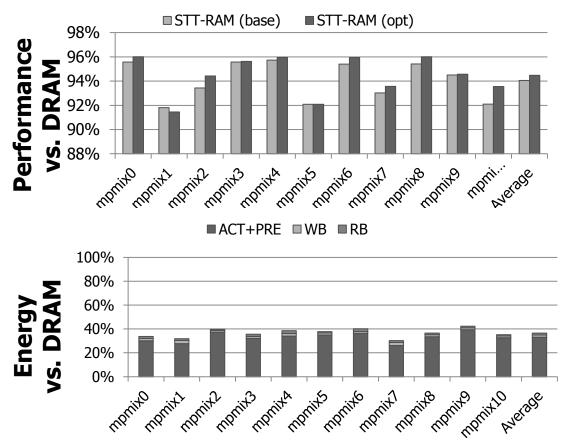


### STT-MRAM: Pros and Cons

- Pros over DRAM
  - Better technology scaling
  - Non volatility
  - Low idle power (no refresh)
- Cons
  - Higher write latency
  - Higher write energy
  - Reliability?
- Another level of freedom
  - Can trade off non-volatility for lower write latency/energy (by reducing the size of the MTJ)

## Architected STT-MRAM as Main Memory

- 4-core, 4GB main memory, multiprogrammed workloads
- ~6% performance loss, ~60% energy savings vs. DRAM



Kultursay+, "Evaluating STT-RAM as an Energy-Efficient Main Memory Alternative," ISPASS 2013.

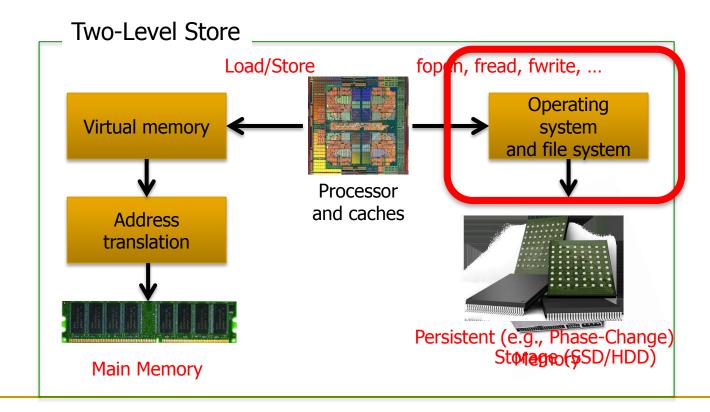
### Other Opportunities with Emerging Technologies

#### Merging of memory and storage

- e.g., a single interface to manage all data
- New applications
  - e.g., ultra-fast checkpoint and restore
- More robust system design
  - e.g., reducing data loss
- Processing tightly-coupled with memory
   e.g., enabling efficient search and filtering

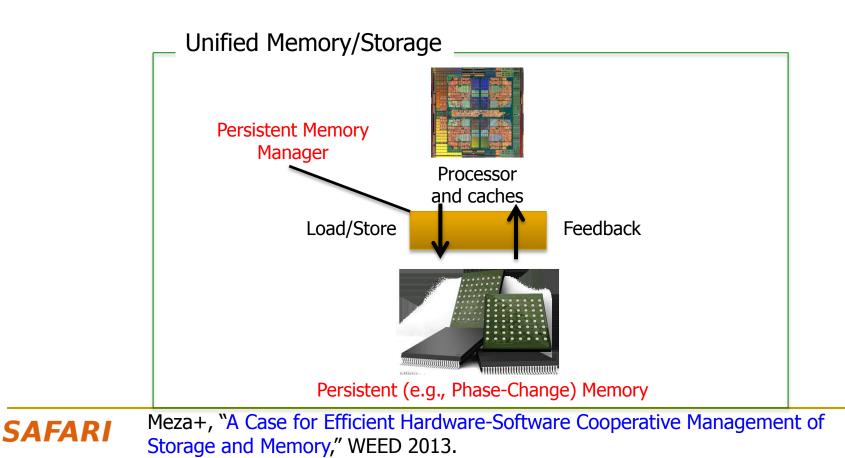
### Coordinated Memory and Storage with NVM (I)

- The traditional two-level storage model is a bottleneck with NVM
  - Volatile data in memory  $\rightarrow$  a load/store interface
  - **Persistent** data in storage  $\rightarrow$  a **file system** interface
  - Problem: Operating system (OS) and file system (FS) code to locate, translate, buffer data become performance and energy bottlenecks with fast NVM stores



### Coordinated Memory and Storage with NVM (II)

- Goal: Unify memory and storage management in a single unit to eliminate wasted work to locate, transfer, and translate data
  - Improves both energy and performance
  - Simplifies programming model as well

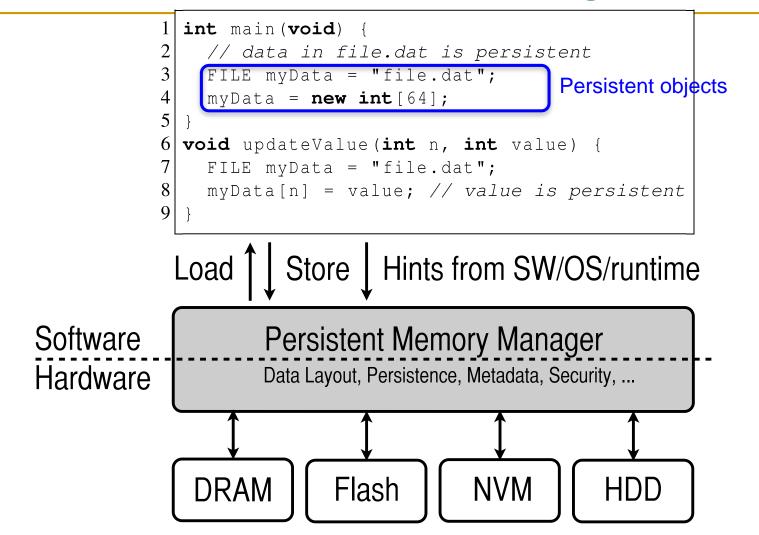


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### The Persistent Memory Manager (PMM)

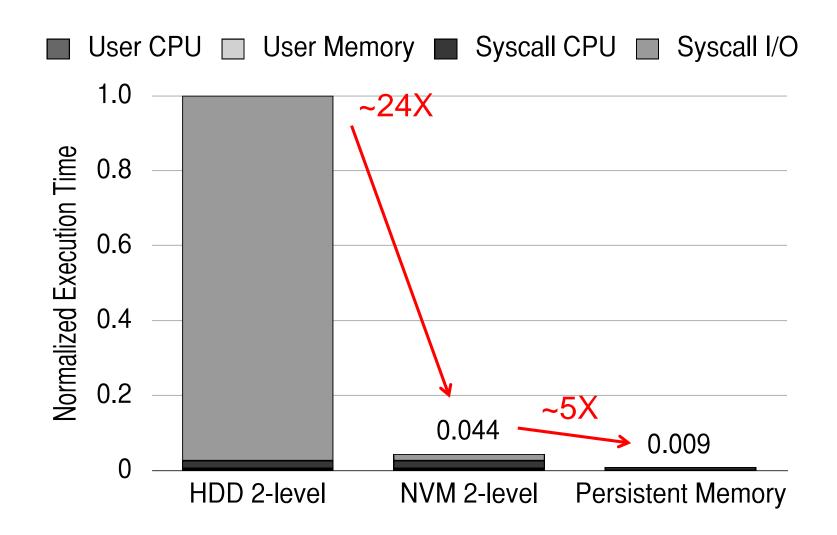
- Exposes a load/store interface to access persistent data
  - □ Applications can directly access persistent memory → no conversion, translation, location overhead for persistent data
- Manages data placement, location, persistence, security
  - To get the best of multiple forms of storage
- Manages metadata storage and retrieval
  - This can lead to overheads that need to be managed
- Exposes hooks and interfaces for system software
  - To enable better data placement and management decisions
- Meza+, "A Case for Efficient Hardware-Software Cooperative Management of Storage and Memory," WEED 2013.

### The Persistent Memory Manager (PMM)



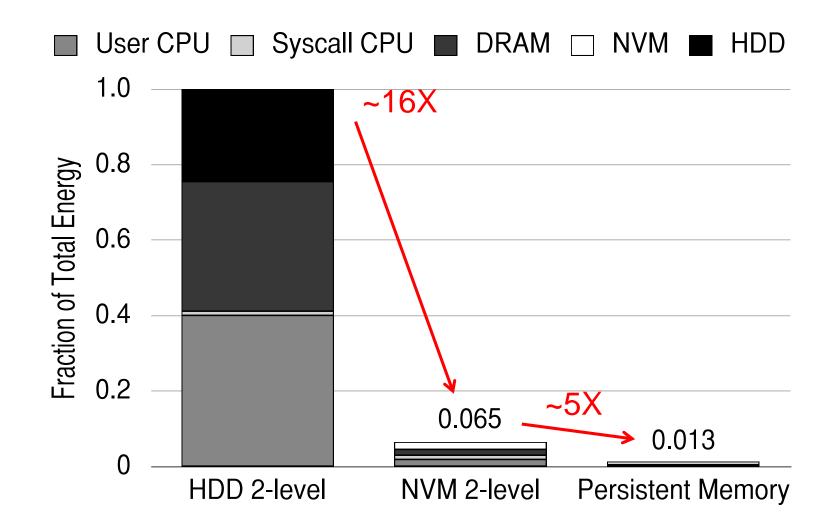
PMM uses access and hint information to allocate, locate, migrate and access data in the heterogeneous array of devices

### Performance Benefits of a Single-Level Store



**SAFARI** Meza+, "A Case for Efficient Hardware-Software Cooperative Management of 139 Storage and Memory," WEED 2013.

### Energy Benefits of a Single-Level Store



**SAFARI** Meza+, "A Case for Efficient Hardware-Software Cooperative Management of 140 Storage and Memory," WEED 2013.



- Major Trends Affecting Main Memory
- The Memory Scaling Problem and Solution Directions
  - New Memory Architectures
  - Enabling Emerging Technologies
- How Can We Do Better?
- Summary

## Principles (So Far)

#### Better cooperation between devices and the system

- Expose more information about devices to upper layers
- More flexible interfaces
- Better-than-worst-case design
  - Do not optimize for the worst case
  - Worst case should not determine the common case
- Heterogeneity in design (specialization, asymmetry)
  - Enables a more efficient design (No one size fits all)
- These principles are coupled



- Major Trends Affecting Main Memory
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  - New Memory Architectures
  - Enabling Emerging Technologies
- How Can We Do Better?
- Summary

## Summary: Memory Scaling

- Memory scaling problems are a critical bottleneck for system performance, efficiency, and usability
- New memory architectures
  - A lot of hope in fixing DRAM
- Enabling emerging NVM technologies
  - A lot of hope in hybrid memory systems and single-level stores
- System-level memory/storage QoS
  - A lot of hope in designing a predictable system
- Three principles are essential for scaling
  - Software/hardware/device cooperation
  - Better-than-worst-case design
  - Heterogeneity (specialization, asymmetry)

## Acknowledgments

#### My current and past students and postdocs

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#### My collaborators elsewhere

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- CyLab
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## Open Source Tools

- Rowhammer
  - <u>https://github.com/CMU-SAFARI/rowhammer</u>
- Ramulator
  - https://github.com/CMU-SAFARI/ramulator
- MemSim
  - https://github.com/CMU-SAFARI/memsim
- NOCulator
  - https://github.com/CMU-SAFARI/NOCulator
- DRAM Error Model
  - http://www.ece.cmu.edu/~safari/tools/memerr/index.html
- Other open-source software from my group
  - <u>https://github.com/CMU-SAFARI/</u>

<u>http://www.ece.cmu.edu/~safari/tools.html</u>
SAFARI

All are available at

http://users.ece.cmu.edu/~omutlu/projects.htm http://scholar.google.com/citations?user=7XyGUGkAAAAJ&hl=en

- A detailed accompanying overview paper
  - Onur Mutlu and Lavanya Subramanian,
     "Research Problems and Opportunities in Memory Systems"
     Invited Article in Supercomputing Frontiers and Innovations (SUPERFRI), 2015.

### Related Videos and Course Materials

- <u>Undergraduate Computer Architecture Course Lecture</u> <u>Videos (2013, 2014, 2015)</u>
- <u>Undergraduate Computer Architecture Course</u> <u>Materials</u> (2013, 2014, 2015)
- <u>Graduate Computer Architecture Course Materials</u> (<u>Lecture Videos</u>)
- Parallel Computer Architecture Course Materials (Lecture Videos)
- Memory Systems Short Course Materials
   (Lecture Video on Main Memory and DRAM Basics)

## Rethinking Memory System Design (for Data-Intensive Computing)

Prof. Onur Mutlu 18-740 Recitation 2 September 8, 2015



### Another Talk: NAND Flash Scaling Challenges

Onur Mutlu,

#### "Error Analysis and Management for MLC NAND Flash Memory"

*Technical talk at <u>Flash Memory Summit 2014</u> (FMS), Santa Clara, CA, August 2014. <u>Slides (ppt) (pdf)</u>* 

Cai+, "Error Patterns in MLC NAND Flash Memory: Measurement, Characterization, and Analysis," DATE 2012.

Cai+, "Flash Correct-and-Refresh: Retention-Aware Error Management for Increased Flash Memory Lifetime," ICCD 2012.

Cai+, "Threshold Voltage Distribution in MLC NAND Flash Memory: Characterization, Analysis and Modeling," DATE 2013.

Cai+, "Error Analysis and Retention-Aware Error Management for NAND Flash Memory," Intel Technology Journal 2013.

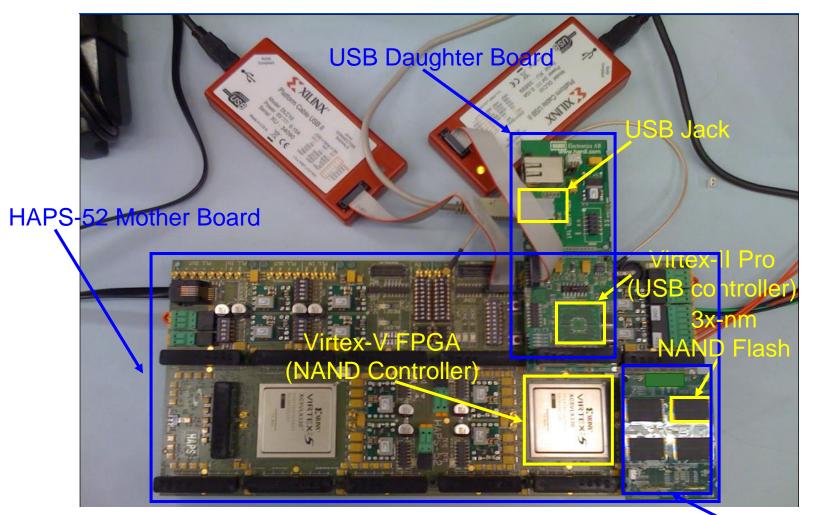
Cai+, "Program Interference in MLC NAND Flash Memory: Characterization, Modeling, and Mitigation," ICCD 2013.

Cai+, "Neighbor-Cell Assisted Error Correction for MLC NAND Flash Memories," SIGMETRICS 2014.

Cai+,"Data Retention in MLC NAND Flash Memory: Characterization, Optimization and Recovery," HPCA 2015.

Cai+, "Read Disturb Errors in MLC NAND Flash Memory: Characterization and Mitigation," DSN 2015. Luo+, "WARM: Improving NAND Flash Memory Lifetime with Write-hotness Aware Retention Management," MSST 2015.

### Experimental Infrastructure (Flash)



[Cai+, DATE 2012, ICCD 2012, DATE 2013, ITJ 2013, ICCD 2013, SIGMETRICS 2014, HPCA 2015, DSN 2015, MSST 2015] NAND Daughter Board